NCP5387

2/3/4 Phase Controller for CPU Applications

The NCP5387 is a two−, three−, or four−phase buck controller which combines differential voltage and current sensing, and adaptive voltage positioning to power both AMD and Intel processors. Dual−edge pulse−width modulation (PWM) combined with inductor current sensing reduces system cost by providing the fastest initial response to transient load events. Dual−edge multi−phase modulation reduces total bulk and ceramic output capacitance required to satisfy transient load−line regulation.

A high performance operational error amplifier is provided, which allows easy compensation of the system. The proprietary method of Dynamic Reference Injection (Patented) makes the error amplifier compensation virtually independent of the system response to VID changes, eliminating tradeoffs between overshoot and dynamic VID performance.

Features

- Meets Intel's VR 10.0 and 11.0 and AMD Specifications
- Dual−Edge PWM for Fastest Initial Response to Transient Loading
- High Performance Operational Error Amplifier
- Supports both VR11 and Legacy Soft−Start Modes
- Dynamic Reference Injection (Patented)
- DAC Range from 0.5 V to 1.6 V
- ±0.5% System Voltage Accuracy from 1.0 V to 1.6 V
- True Differential Remote Voltage Sensing Amplifier
- Phase−to−Phase Current Balancing
- "Lossless" Differential Inductor Current Sensing
- Differential Current Sense Amplifiers for each Phase
- Adaptive Voltage Positioning (AVP)
- Frequency Range: 100 kHz – 1.0 MHz
- OVP with Resettable, 8 Event Delayed Latch
- Threshold Sensitive Enable Pin for VTT Sensing
- Power Good Output with Internal Delays
- Programmable Soft−Start Time
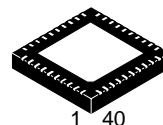- This is a Pb−Free Device*
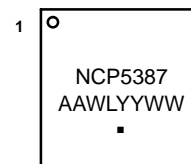
Applications

- Desktop Processors

ON Semiconductor®

http://onsemi.com

40 PIN QFN, 6x6
MN SUFFIX
CASE 488AR

1   40

MARKING DIAGRAM

1 o

NCP5387
AAWLYYWW
▪

NCP5387 = Specific Device Code
AA = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week
▪/G = Pb−Free Package

*Pin 41 is the thermal pad on the bottom of the device.

ORDERING INFORMATION

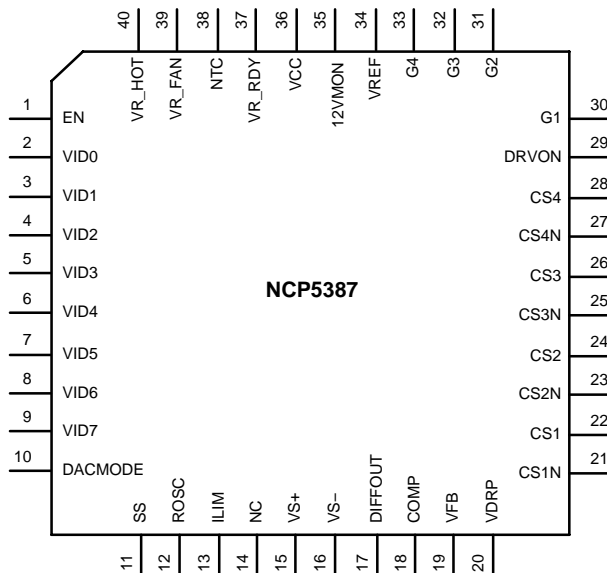| Device	Package	Shipping[†]
NCP5387MNR2G*	QFN−40 (Pb−Free)	2500 / Tape & Reel

*Temperature Range: 0°C to 85°C

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

1

NCP5387

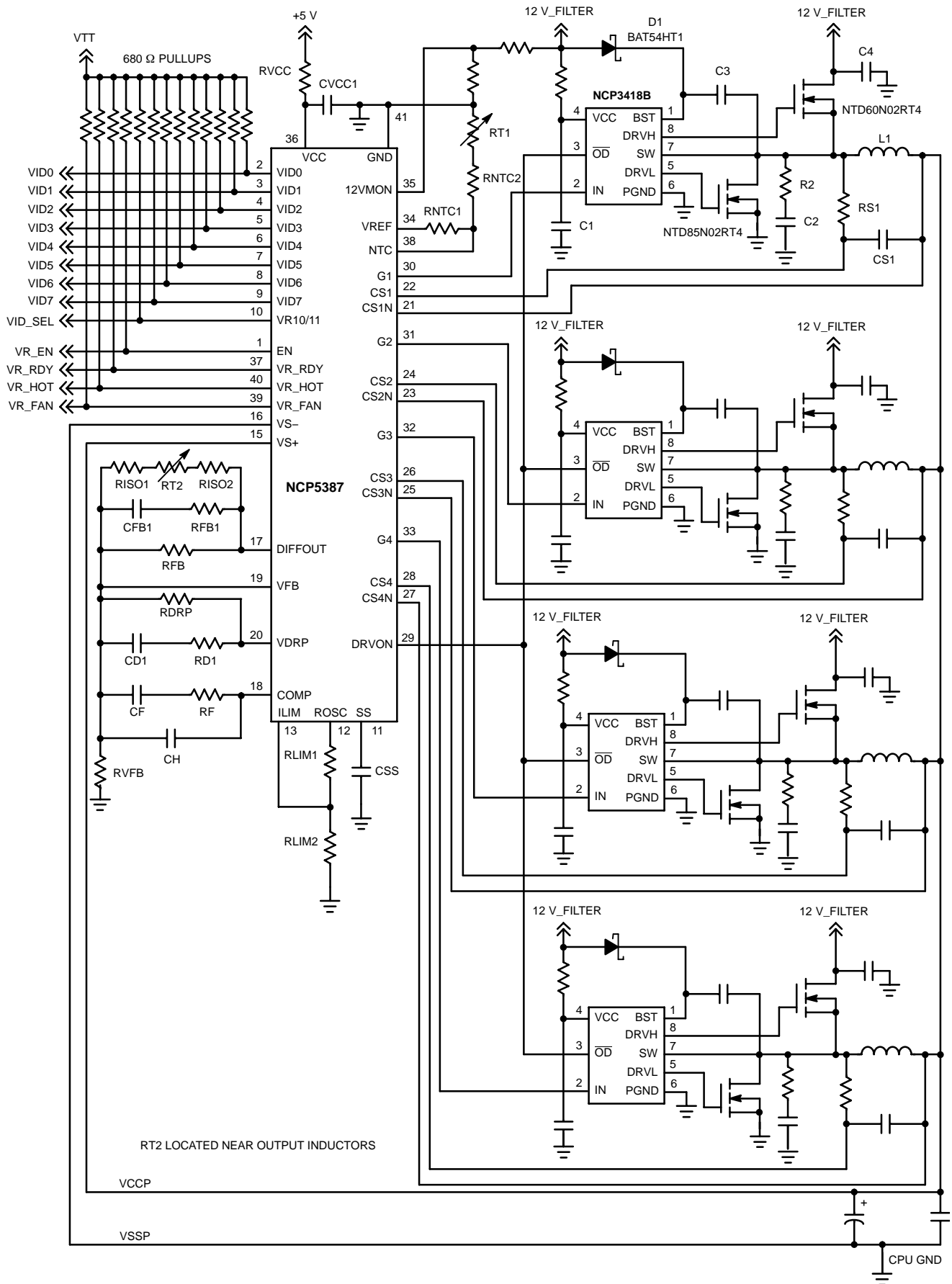## PIN CONNECTIONS

(Top View)

NCP5387

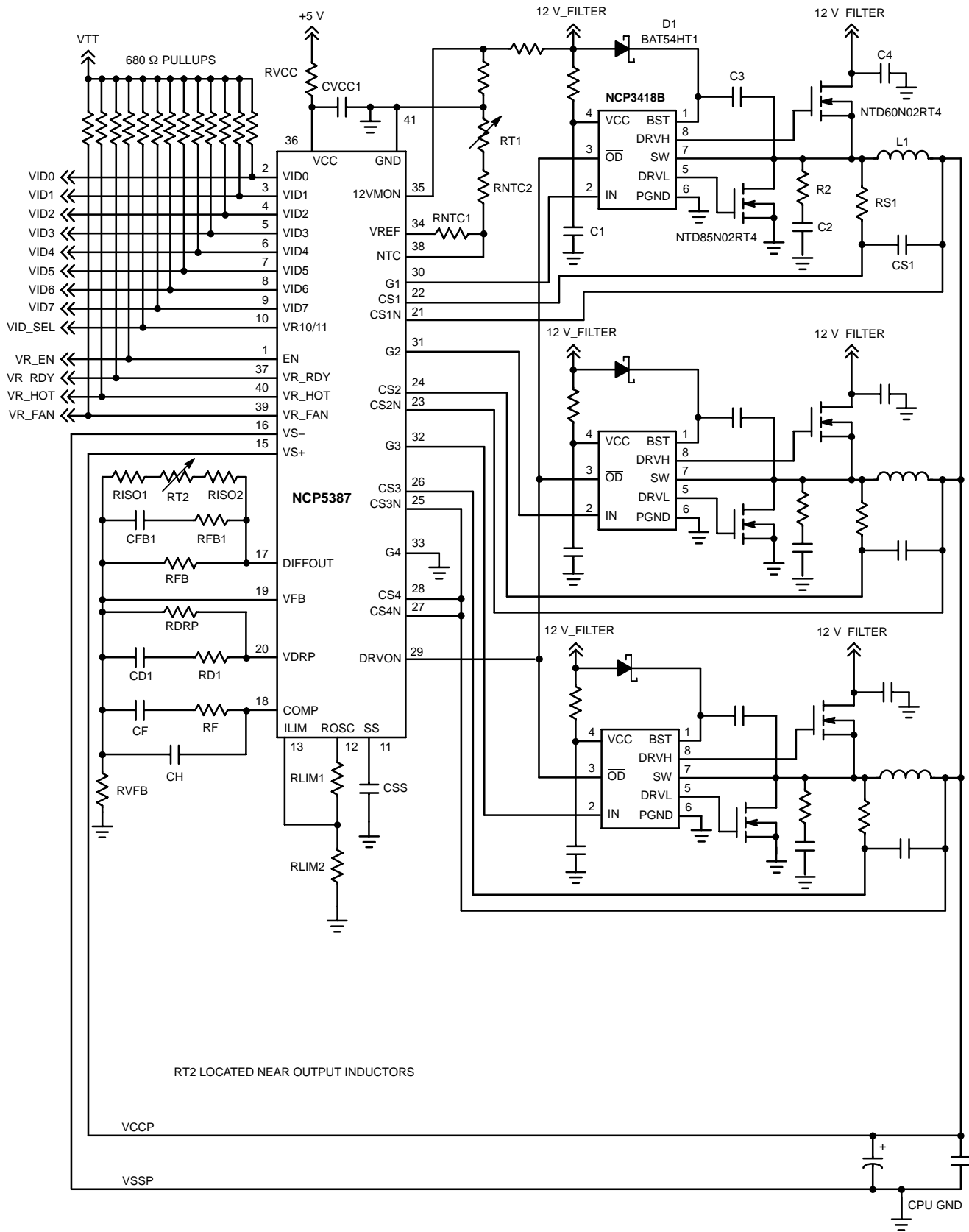**Figure 1. Application Schematic for Four Phases**

NCP5387

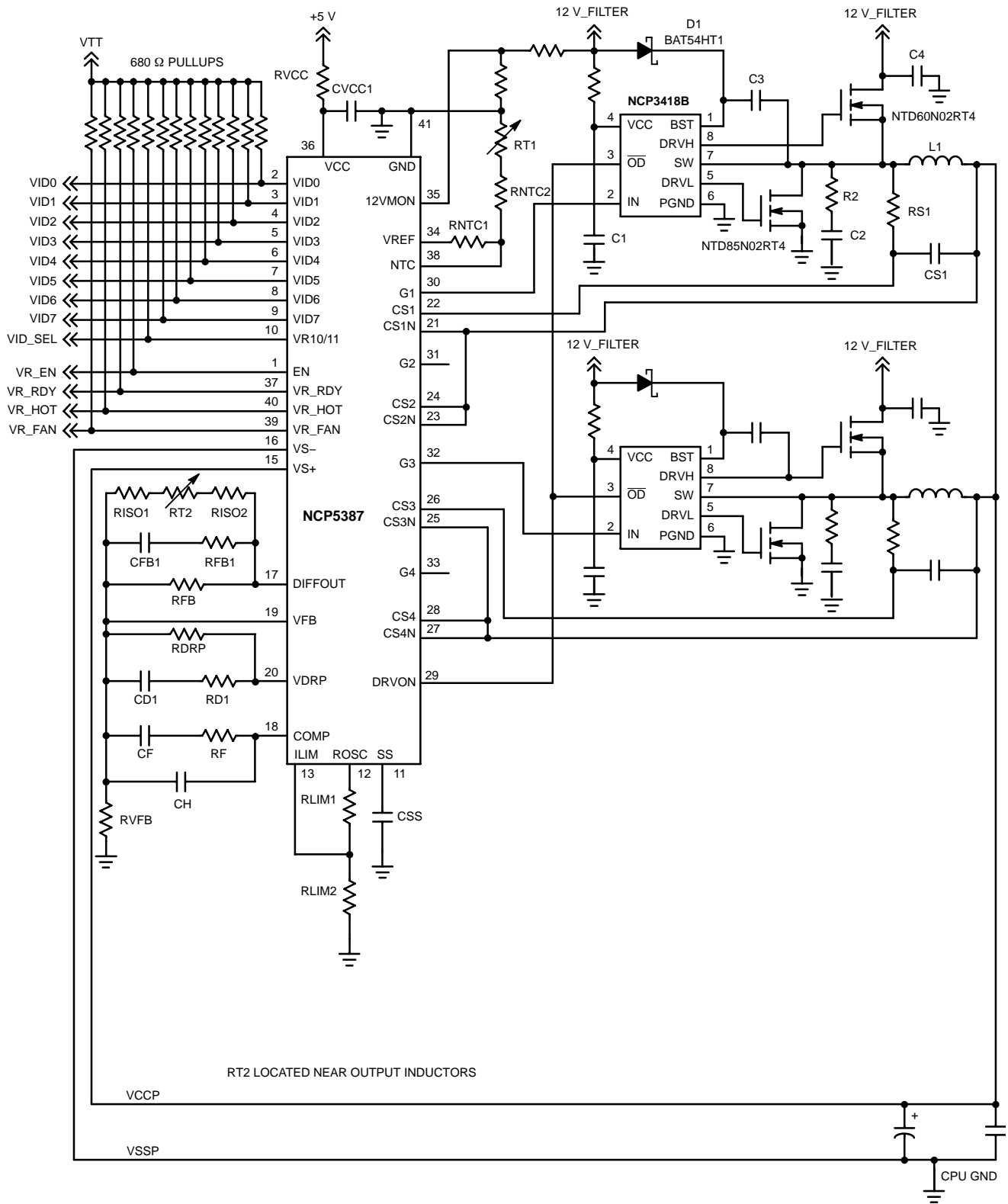**Figure 2. Application Schematic for Three Phases**

NCP5387

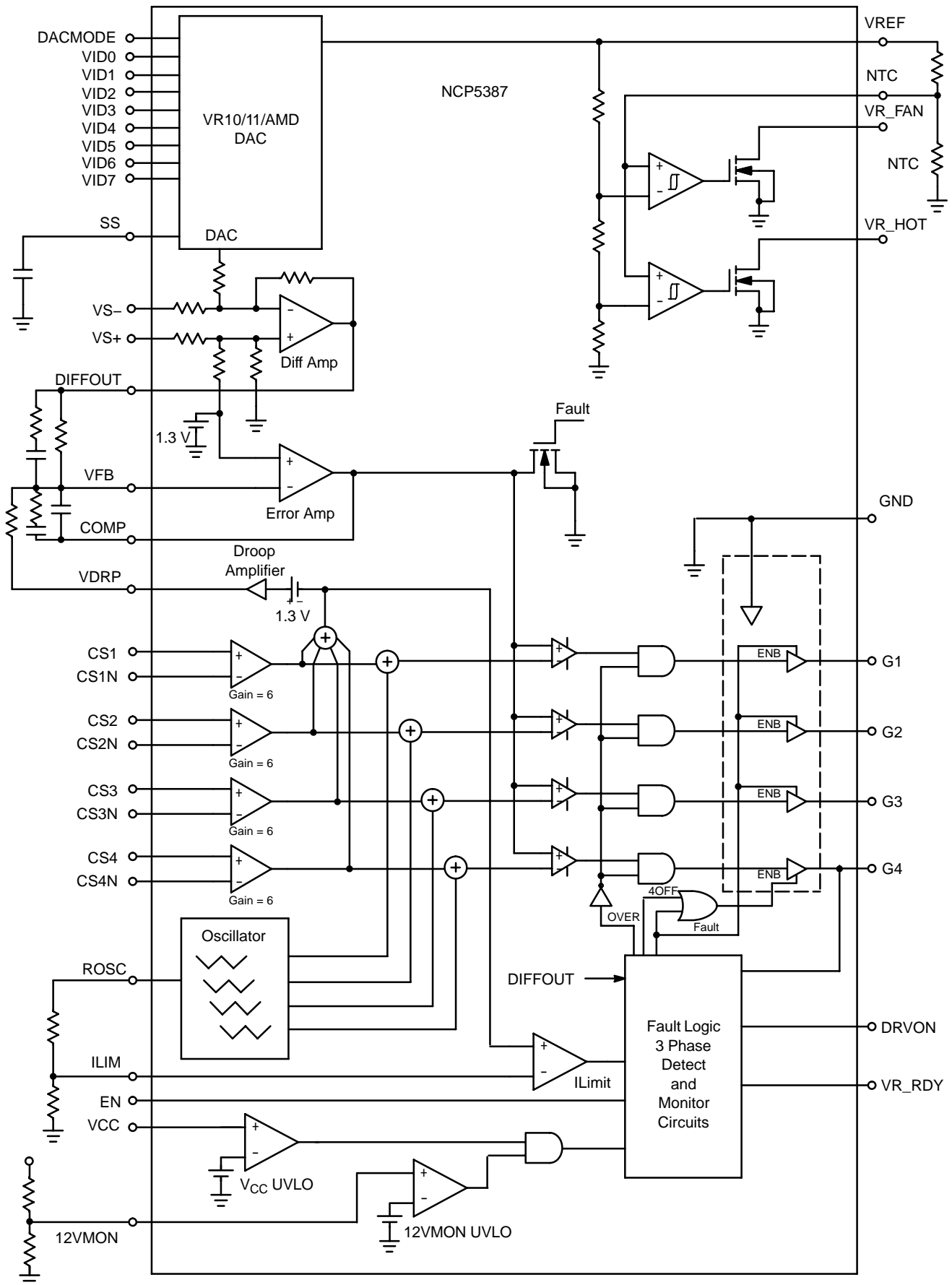**Figure 3. Application Schematic for Two Phases**

NCP5387

Figure 4. Simplified Block Diagram

NCP5387

PIN DESCRIPTIONS

Pin No.	Symbol	Description
1	EN	Pull this pin high to enable controller. Pull this pin low to disable controller. Either an open–collector output (with a pull–up resistor) or a logic gate (CMOS or totem–pole output) may be used to drive this pin. A Low–to–High transition on this pin will initiate a soft start. Connect this pin directly to VREF if the Enable function is not required. 20 MHz filtering at this pin is required.
2 – 9	VID0–VID7	Voltage ID DAC inputs
10	DACMODE	VRM select bit
11	SS	A capacitor from this pin to ground programs the soft–start time.
12	ROSC	A resistance from this pin to ground programs the oscillator frequency. Also, this pin supplies an output voltage of 2 V which may be used to form a voltage divider to the ILIM pin to set the over–current shutdown threshold as shown in the Applications Schematics.
13	ILIM	Over–current shutdown threshold. To program the shutdown threshold, connect this pin to the ROSC pin via a resistor divider as shown in the Applications Schematics. To disable the over–current feature, connect this pin directly to the ROSC pin. To guarantee correct operation, this pin should only be connected to the voltage generated by the ROSC pin; do not connect this pin to any externally generated voltages.
14	NC	Do not connect anything to this pin.
15	VS+	Non–inverting input to the internal differential remote sense amplifier
16	VS–	Inverting input to the internal differential remote sense amplifier
17	DIFFOUT	Output of the differential remote sense amplifier
18	COMP	Output of the error amplifier, and the non–inverting input of the PWM comparators
19	VFB	Error amplifier inverting input. Connect a resistor from this pin to DIFFOUT. The value of this resistor and the amount of current from the droop resistor (RDRP) will set the amount of output voltage droop (AVP) during load.
20	VDRP	Current signal output for Adaptive Voltage Positioning (AVP). The voltage of this pin above the 1.3 V internal offset voltage is proportional to the output current. Connect a resistor from this pin to VFB to set the amount of AVP current into the feedback resistor (RFB) to produce an output voltage droop. Leave this pin open for no AVP.
21, 23, 25, 27	CSxN	Inverting input to current sense amplifier #x, x = 1, 2, 3, 4.
22, 24, 26, 28	CSx	Non–inverting input to current sense amplifier #x, x = 1, 2, 3, 4.
29	DRVON	Output to enable Gate Drivers
30 – 33	G1 – G4	PWM output pulses to gate drivers
34	VREF	Voltage reference output. This pin is used for remote temperature sensing as shown in the Applications Schematic.
35	12VMON	Second UVLO monitor for monitoring the power stage supply rail
36	VCC	Power for the internal control circuits.
37	VR_RDY	Voltage Regulator Ready (Power Good) output. Open drain output that is high when the output is regulating.
38	NTC	Remote temperature sense connection. Connect an NTC thermistor from this pin to GND and a resistor from this pin to VREF. As the NTC's temperature increases, the voltage on this pin will decrease.
39	VR_FAN	Open drain output that will be low impedance when the voltage at the NTC pin is above the specified threshold. This pin will transition to a high impedance state when the voltage at the NTC pin decreases below the specified threshold. This pin requires an external pull–up resistor.
40	VR_HOT	Open drain output that will be low impedance when the voltage at the NTC pin is above the specified threshold. This pin will transition to a high impedance state when the voltage at the NTC pin decreases below the specified threshold. This pin requires an external pull–up resistor.
41	GND	Power supply return (QFN Flag)

NCP5387

MAXIMUM RATINGS

Electrical Information

Pin Symbol	V$_{MAX}$ (V)	V$_{MIN}$ (V)	I$_{SOURCE}$ (mA)	I$_{SINK}$ (mA)
COMP	5.5	−0.3	10	10
VDRP	5.5	−0.3	5	5
VS+	2.0	GND − 300 mV	1	1
VS−	2.0	GND − 300 mV	1	1
DIFFOUT	5.5	−0.3	20	20
VR_RDY, VR_HOT, VR_FAN	5.5	−0.3	N/A	20
VCC	7.0	−0.3	N/A	10
ROSC	5.5	−0.3	1	N/A
DACMODE, EN	3.5	−0.3	0	0
V$_{REF}$	5.5	−0.3	0.5	N/A
All Other Pins	5.5	−0.3	−	−

*All signals reference to GND unless otherwise noted.

Thermal Information

Rating	Symbol	Value	Unit
Thermal Characteristic, QFN Package (Note 1)	R$_{\theta JA}$	34	°C/W
Operating Junction Temperature Range (Note 2)	T$_J$	0 to 125	°C
Operating Ambient Temperature Range	T$_A$	0 to 85	°C
Maximum Storage Temperature Range	T$_{STG}$	−55 to +150	°C
Moisture Sensitivity Level, QFN Package	MSL	3	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.
*The maximum package power dissipation must be observed.
1. JESD 51−5 (1S2P Direct−Attach Method) with 0 Airflow.
2. JESD 51−7 (1S2P Direct−Attach Method) with 0 Airflow.

ELECTRICAL CHARACTERISTICS

(Unless otherwise stated: 0°C < T_A < 85°C; 4.75 V < V_{CC} < 5.25 V; All DAC Codes; C_{VCC} = 0.1 μF)

Parameter	Test Conditions	Min	Typ	Max	Units
Error Amplifier					
Input Bias Current		−200	–	200	nA
Input Offset Voltage (Note 3)		−1.0	–	1.0	mV
Open Loop DC Gain (Note 3)	C_L = 60 pF to GND, R_L = 10 kΩ to GND	–	100	–	dB
Open Loop Unity Gain Bandwidth (Note 3)	C_L = 60 pF to GND, R_L = 10 kΩ to GND	–	15	–	MHz
Open Loop Phase Margin (Note 3)	C_L = 60 pF to GND, R_L = 10 kΩ to GND	–	70	–	°
Slew Rate (Note 3)	ΔV_{in} = 100 mV, G = −10 V/V, 1.5 V < COMP < 2.5 V, C_L = 60 pF, DC Load = ±125 μA	–	5	–	V/μs
Maximum Output Voltage	10 mV of Overdrive I_{SOURCE} = 2.0 mA	2.20	V_{CC}−20 mV	–	V
Minimum Output Voltage	10 mV of Overdrive I_{SINK} = 2.0 mA	–	0.01	0.5	V
Output Source Current (Note 3)	10 mV Input Overdrive COMP = 2.0 V	2.0	–	–	mA
Output Sink Current (Note 3)	10 mV Input Overdrive COMP = 1.0 V	2.0	–	–	mA
Differential Summing Amplifier					
VS+ Input Resistance	DRVON = Low DRVON = High	– –	1.5 17	– –	kΩ
VS+ Input Bias Voltage	DRVON = Low DRVON = High	– –	0.05 0.65	– –	V
VS− Bias Current	VS− = 0 V	–	33	–	μA
VS+ Input Voltage Range	$0.95 \leq \Delta$DIFFOUT / ΔVS− ≤ 1.05 0.5 V $\leq$ DIFFOUT $\leq$ 2.0 V	−0.3	–	2.0	V
VS− Input Voltage Range	$0.95 \leq \Delta$DIFFOUT / ΔVS− ≤ 1.05 0.5 V $\leq$ DIFFOUT $\leq$ 2.0 V	−0.3	–	0.3	V
DC Gain VS+ to DIFFOUT	0 V $\leq$ DAC − VS+ $\leq$ 0.3 V	0.98	1.0	1.025	V/V
DAC Accuracy (measured at VS+)	Closed loop measurement including error amplifier. (See Figure 25) $1.0 \leq$ DAC ≤ 1.6 $0.8 \leq$ DAC ≤ 1.0 $0.5 \leq$ DAC ≤ 0.8	 −0.5 −5 −8	 – – –	 0.5 5 8	 % mV mV
−3dB Bandwidth (Note 3)	C_L = 80 pF to GND, R_L = 10 kΩ to GND	–	10	–	MHz
Slew Rate (Note 3)	ΔV_{in} = 100 mV, DIFFOUT = 1.3 V to 1.2 V	–	5	–	V/μs
Maximum Output Voltage	VS+ − DAC = 1.0 V I_{SOURCE} = 2.0 mA	2.0	3.0	–	V
Minimum Output Voltage	VS+ − DAC = −0.8 V I_{SINK} = 2.0 mA	–	0.01	0.5	V
Output Source Current (Note 3)	VS+ − DAC = 1.0 V DIFFOUT = 1.0 V	2.0	–	–	mA
Output Sink Current (Note 3)	VS+ − DAC = −0.8 V DIFFOUT = 1.0 V	2.0	–	–	mA

3. Guaranteed by design. Not tested in production.

NCP5387

ELECTRICAL CHARACTERISTICS

(Unless otherwise stated: 0°C < T_A < 85°C; 4.75 V < V_{CC} < 5.25 V; All DAC Codes; C_{VCC} = 0.1 μF)

Parameter	Test Conditions	Min	Typ	Max	Units
Internal Offset Voltage					
VDRP pin offset voltage AND Error Amp input voltage		–	1.30		V
VDRP Adaptive Voltage–Positioning Amplifier					
Current Sense Input to VDRP Gain	–60 mV < (CSx–CSxN) < +60 mV (Each CS Input Independently)	5.64	5.79	5.95	V/V
Current Sense Input to VDRP –3dB Bandwidth (Note 3)	C_L = 30 pF to GND, R_L = 10 kΩ to GND	–	4	–	MHz
VDRP Output Slew Rate (Note 3)	ΔVin = 25 mV 1.3 V < VDRP < 1.9 V, C_L = 330 pF to GND, R_L = 1 kΩ to 10 kΩ connected to 1.3 V	2.5	–	–	V/μs
VDRP Output Voltage Offset from Internal Offset Voltage	CSx= CSxN = 1.3 V	–15	–	+15	mV
Maximum VDRP Output Voltage	CSx – CSxN = 0.1 V (all phases), I_{SOURCE} = 1.0 mA	2.6	3.0	–	V
Minimum VDRP Output Voltage	CSx – CSxN = –0.033 V (all phases), I_{SINK} = 1.0 mA	–	0.1	0.5	V
Output Source Current (Note 3)	VDRP = 2.0 V	–	1.3	–	mA
Output Sink Current (Note 3)	VDRP = 1.0 V	–	25	–	mA
Current Sense Amplifiers					
Input Bias Current	CSx = CSxN = 1.4 V	–200	–	200	nA
Common Mode Input Voltage Range		–0.3	–	2.0	V
Differential Mode Input Voltage Range (Note 3)		–120	–	120	mV
Input Referred Offset Voltage (Note 3)	CSx = CSxN = 1.0 V	–1.0	–	1.0	mV
Current Sense Input to PWM Gain	0 V < (CSx – CSxN) < 0.1 V	–	6.0	–	V/V
Oscillator					
Switching Frequency Range (Note 3)		100	–	1000	kHz
Switching Frequency Accuracy, 2– or 4–phase	ROSC = 50 kΩ 25 kΩ 10 kΩ	196 380 803	– – –	226 420 981	kHz
Switching Frequency Accuracy, 3–phase	ROSC = 50 kΩ 25 kΩ 10 kΩ	196 370 757	– – –	230 430 963	kHz
Switching Frequency Tolerance, 2 and 4 Phase Operation (Note 3)	200 kHz < FSW < 600 kHz 100 kHz < FSW <1 MHz	– –	5 10	– –	%
Switching Frequency Tolerance, 3 Phase Operation (Note 3)	200 kHz < FSW < 600 kHz 100 kHz < FSW <1 MHz	– –	10 15	– –	%
ROSC Output Voltage	40 μA ≤ I_{ROSC} ≤ 200 μA	1.95	2.01	2.065	V

NCP5387

ELECTRICAL CHARACTERISTICS

(Unless otherwise stated: 0°C < T_A < 85°C; 4.75 V < V_{CC} < 5.25 V; All DAC Codes; C_{VCC} = 0.1 μF)

Parameter	Test Conditions	Min	Typ	Max	Units
Modulators (PWM Comparators)					
Minimum Pulse Width (Note 3)	Fs = 800 kHz	–	30	40	ns
Propagation Delay (Note 3)		–	20	–	ns
Magnitude of the PWM Ramp		–	1.0	–	V
0% Duty Cycle	COMP voltage when the PWM outputs remain LOW	–	1.3	–	V
100% Duty Cycle	COMP voltage when the PWM outputs remain HIGH	–	2.3	–	V
PWM Linear Duty Cycle (Note 3)		–	90	–	%
PWM Phase Angle Error		–15	–	15	°
VR_RDY (Power Good) Output					
VR_RDY Saturation Voltage	I_{VR_RDY} = 10 mA	–	–	0.4	V
VR_RDY Rise Time	External pullup of 680 kΩ to 1.25 V, C_L = 45 pF, ΔVo = 10% to 90%	–	–	150	ns
VR_RDY High – Output Leakage Current	VR_RDY = 5.0 V	–	–	1.0	μA
VR_RDY Upper Threshold Voltage	VCORE increasing, DAC = 1.3 V	–	300	–	mV below DAC
VR_RDY Lower Threshold Voltage	VCORE decreasing, DAC = 1.3 V	–	350	–	mV below DAC
VR_RDY Rising Delay	VCORE increasing	–	–	3	ms
VR_RDY Falling Delay	VCORE decreasing	–	–	250	ns
PWM Outputs					
Output High Voltage	Sourcing 500 μA	3.0	–	V_{CC}	V
Output Low Voltage	Sinking 500 μA	–	–	0.15	V
Rise Time	C_L = 20 pF, ΔVo = 0.3 to 2.0 V	–	–	20	ns
Fall Time	C_L = 20 pF, ΔVo = Vmax to 0.7 V	–	–	20	ns
Tri–State Output Leakage	Gx = 2.5 V, x = 1 – 4	–	–	1.5	μA
Output Impedance – Sourcing	Max Resistance to V_{CC}	–	320	–	Ω
Output Impedance – Sinking	Max Resistance to GND	–	140	–	Ω
2/3/4 Phase Detection					
Gate Pin Source Current		–	84	–	μA
Gate Pin Threshold Voltage		–	225	–	mV
Phase Detect Timer		–	20	–	μs
DRVON					
Output High Voltage	Sourcing 500 μA	3.0	–	V_{CC}	V
Output Low Voltage	Sinking 500 μA	–	–	0.7	mV
Rise Time	C_L (PCB) = 20 pF, ΔVo = 10% to 90%	–	24	30	ns
Fall Time	C_L = 20 pF, ΔVo = 10% to 90%	–	11	20	ns
Internal Pulldown Resistance		–	70	–	kΩ

NCP5387

ELECTRICAL CHARACTERISTICS

(Unless otherwise stated: 0°C < T_A < 85°C; 4.75 V < V_{CC} < 5.25 V; All DAC Codes; C_{VCC} = 0.1 μF)

Parameter	Test Conditions	Min	Typ	Max	Units
Soft–Start					
Soft–Start Pin Source Current		3.75	5.0	6.25	μA
Soft–Start Ramp Time	C_{SS} = 0.01 μF; Time to 1.05 V	–	2.2	–	ms
Soft–Start Pin Discharge Voltage	DRVON pin = LO (Fault)	–	–	25	mV
VR11 Dwell Time at V_{BOOT}	C_{SS} = 0.01 μF	50	–	500	μs
DACMODE Input					
Input Range for AMD Operating Mode		2.3	–	3.5	V
Input Range for VR11 Operating Mode		0.9	–	1.7	V
Input Range for VR10 Operating Mode		0	–	0.5	V
Enable Input					
Enable High Input Leakage Current	EN = 3.3 V	–	–	1.0	μA
Rising Threshold	V_{UPPER}	0.800	–	0.920	V
Falling Threshold	V_{LOWER}	0.670	–	0.830	V
Hysteresis	$V_{UPPER} - V_{LOWER}$	–	130	–	mV
Enable Delay Time	Time from Enable transitioning HI to initiation of Soft–Start	1.0	–	5.0	ms
Disable Delay Time	EN Low to DRVON Low	–	150	200	ns
Current Limit					
Current Sense Amp to ILIM Gain	20 mV < (CSx – CSxN) < 60 mV (Each CS Input Independently)	5.7	5.95	6.2	V/V
ILIM Pin Input Bias Current	V_{ILIM} = 2.0 V	–	–	1.0	μA
ILIM Pin Working Voltage Range (Note 3)		0.2	–	2.0	V
ILIM Offset Voltage	Offset extrapolated to CSx – CSxN = 0, referred to ILIM pin	–33	17	67	mV
Delay (Note 3)		–	300	–	ns
Overvoltage Protection					
Overvoltage Threshold		DAC+ 160	–	DAC+ 200	mV
Delay (Note 3)		–	100	–	ns
Undervoltage Protection					
V_{CC} UVLO Start Threshold		4	–	4.5	V
V_{CC} UVLO Stop Threshold		3.8	–	4.3	V
V_{CC} UVLO Hysteresis		100	215	–	mV
VID Inputs					
Upper Threshold	V_{UPPER}	–	–	800	mV
Lower Threshold	V_{LOWER}	300	–	–	mV
Input Bias Current		–	–	500	nA
Delay before Latching VID Change (VID De–Skewing) (Note 3)	Measured from the edge of the first VID change	500	–	800	ns
Internal DAC Slew Rate Limiter					
Positive Slew Rate Limit	V_{ID} Step of +500 mV	–	6.3	–	mV/μs
Negative Slew Rate Limit	V_{ID} Step of –500 mV	–	–6.3	–	mV/μs

NCP5387

ELECTRICAL CHARACTERISTICS

(Unless otherwise stated: $0°C < T_A < 85°C$; 4.75 V < V_{CC} < 5.25 V; All DAC Codes; C_{VCC} = 0.1 μF)

Parameter	Test Conditions	Min	Typ	Max	Units
Voltage Reference (V$_{REF}$)					
V$_{REF}$ Output Voltage	0 μA $\leq$ I$_{VREF}$ $\leq$ 500 μA	2.469	2.52	2.569	V
Input Supply Current					
V$_{CC}$ Operating Current	EN = LOW, No PWM	–	–	20	mA
Temperature Sensing					
VR_FAN Upper Voltage Threshold	Fraction of V$_{REF}$ voltage above which VR_FAN output pulls low	–	0.4 x V$_{REF}$	–	–
VR_FAN Lower Voltage Threshold	Fraction of V$_{REF}$ voltage below which VR_FAN output is open	–	0.33 x V$_{REF}$	–	–
VR_HOT Upper Voltage Threshold	Fraction of V$_{REF}$ voltage above which VR_HOT output pulls low	–	0.33 x V$_{REF}$	–	–
VR_HOT Lower Voltage Threshold	Fraction of V$_{REF}$ voltage below which VR_HOT output is open	–	0.27 x V$_{REF}$	–	–
VR_FAN Output Saturation Voltage	I$_{SINK}$ = 4 mA	–	–	0.3	V
VR_FAN Output Leakage Current	High Impedance State	–	–	1	μA
VR_HOT Saturation Output Voltage	I$_{SINK}$ = 4 mA	–	–	0.3	V
VR_HOT Output Leakage Current	High Impedance State	–	–	1	μA
NTC Pin Bias Current		–	–	1	μA
12VMON					
12VMON (Rising Threshold)	Sufficient power stage supply voltage	0.728	–	0.821	V
12VMON (Falling Threshold)	Insufficient power stage supply voltage	0.643	–	0.725	V

NCP5387

ELECTRICAL CHARACTERISTICS
(Unless otherwise stated: 0°C < T_A < 85°C; 4.75 V < V_{CC} < 5.25 V; All DAC Codes; C_{VCC} = 0.1 μF)

Parameter	Test Conditions	Min	Typ	Max	Units
VRM11 DAC					
System Voltage Accuracy	1.0 V < DAC < 1.6 V 0.8 V < DAC < 1.0 V 0.5 V < DAC < 0.8 V	– 	– 	±0.5 ±5 ±8	% mV mV
No Load Offset Voltage from Nominal DAC Specification	With CS Input ΔV_{in} = 0 V	–	–19	–	mV

Table 1: VRM11 VID Codes

VID7 800 mV	VID6 400 mV	VID5 200 mV	VID4 100 mV	VID3 50 mV	VID2 25 mV	VID1 12.5 mV	VID0 6.25 mV	Voltage (V)	HEX
0	0	0	0	0	0	0	0	OFF	00
0	0	0	0	0	0	0	1	OFF	01
0	0	0	0	0	0	1	0	1.60000	02
0	0	0	0	0	0	1	1	1.59375	03
0	0	0	0	0	1	0	0	1.58750	04
0	0	0	0	0	1	0	1	1.58125	05
0	0	0	0	0	1	1	0	1.57500	06
0	0	0	0	0	1	1	1	1.56875	07
0	0	0	0	1	0	0	0	1.56250	08
0	0	0	0	1	0	0	1	1.55625	09
0	0	0	0	1	0	1	0	1.55000	0A
0	0	0	0	1	0	1	1	1.54375	0B
0	0	0	0	1	1	0	0	1.53750	0C
0	0	0	0	1	1	0	1	1.53125	0D
0	0	0	0	1	1	1	0	1.52500	0E
0	0	0	0	1	1	1	1	1.51875	0F
0	0	0	1	0	0	0	0	1.51250	10
0	0	0	1	0	0	0	1	1.50625	11
0	0	0	1	0	0	1	0	1.50000	12
0	0	0	1	0	0	1	1	1.49375	13
0	0	0	1	0	1	0	0	1.48750	14
0	0	0	1	0	1	0	1	1.48125	15
0	0	0	1	0	1	1	0	1.47500	16
0	0	0	1	0	1	1	1	1.46875	17
0	0	0	1	1	0	0	0	1.46250	18
0	0	0	1	1	0	0	1	1.45625	19
0	0	0	1	1	0	1	0	1.45000	1A
0	0	0	1	1	0	1	1	1.44375	1B
0	0	0	1	1	1	0	0	1.43750	1C
0	0	0	1	1	1	0	1	1.43125	1D
0	0	0	1	1	1	1	0	1.42500	1E
0	0	0	1	1	1	1	1	1.41875	1F
0	0	1	0	0	0	0	0	1.41250	20
0	0	1	0	0	0	0	1	1.40625	21
0	0	1	0	0	0	1	0	1.40000	22
0	0	1	0	0	0	1	1	1.39375	23
0	0	1	0	0	1	0	0	1.38750	24

Table 1: VRM11 VID Codes

VID7 800 mV	VID6 400 mV	VID5 200 mV	VID4 100 mV	VID3 50 mV	VID2 25 mV	VID1 12.5 mV	VID0 6.25 mV	Voltage (V)	HEX
0	0	1	0	0	1	0	1	1.38125	25
0	0	1	0	0	1	1	0	1.37500	26
0	0	1	0	0	1	1	1	1.36875	27
0	0	1	0	1	0	0	0	1.36250	28
0	0	1	0	1	0	0	1	1.35625	29
0	0	1	0	1	0	1	0	1.35000	2A
0	0	1	0	1	0	1	1	1.34375	2B
0	0	1	0	1	1	0	0	1.33750	2C
0	0	1	0	1	1	0	1	1.33125	2D
0	0	1	0	1	1	1	0	1.32500	2E
0	0	1	0	1	1	1	1	1.31875	2F
0	0	1	1	0	0	0	0	1.31250	30
0	0	1	1	0	0	0	1	1.30625	31
0	0	1	1	0	0	1	0	1.30000	32
0	0	1	1	0	0	1	1	1.29375	33
0	0	1	1	0	1	0	0	1.28750	34
0	0	1	1	0	1	0	1	1.28125	35
0	0	1	1	0	1	1	0	1.27500	36
0	0	1	1	0	1	1	1	1.26875	37
0	0	1	1	1	0	0	0	1.26250	38
0	0	1	1	1	0	0	1	1.25625	39
0	0	1	1	1	0	1	0	1.25000	3A
0	0	1	1	1	0	1	1	1.24375	3B
0	0	1	1	1	1	0	0	1.23750	3C
0	0	1	1	1	1	0	1	1.23125	3D
0	0	1	1	1	1	1	0	1.22500	3E
0	0	1	1	1	1	1	1	1.21875	3F
0	1	0	0	0	0	0	0	1.21250	40
0	1	0	0	0	0	0	1	1.20625	41
0	1	0	0	0	0	1	0	1.20000	42
0	1	0	0	0	0	1	1	1.19375	43
0	1	0	0	0	1	0	0	1.18750	44
0	1	0	0	0	1	0	1	1.18125	45
0	1	0	0	0	1	1	0	1.17500	46
0	1	0	0	0	1	1	1	1.16875	47
0	1	0	0	1	0	0	0	1.16250	48
0	1	0	0	1	0	0	1	1.15625	49
0	1	0	0	1	0	1	0	1.15000	4A
0	1	0	0	1	0	1	1	1.14375	4B
0	1	0	0	1	1	0	0	1.13750	4C
0	1	0	0	1	1	0	1	1.13125	4D
0	1	0	0	1	1	1	0	1.12500	4E
0	1	0	0	1	1	1	1	1.11875	4F
0	1	0	1	0	0	0	0	1.11250	50
0	1	0	1	0	0	0	1	1.10625	51
0	1	0	1	0	0	1	0	1.10000	52

Table 1: VRM11 VID Codes

VID7 800 mV	VID6 400 mV	VID5 200 mV	VID4 100 mV	VID3 50 mV	VID2 25 mV	VID1 12.5 mV	VID0 6.25 mV	Voltage (V)	HEX
0	1	0	1	0	0	1	1	1.09375	53
0	1	0	1	0	1	0	0	1.08750	54
0	1	0	1	0	1	0	1	1.08125	55
0	1	0	1	0	1	1	0	1.07500	56
0	1	0	1	0	1	1	1	1.06875	57
0	1	0	1	1	0	0	0	1.06250	58
0	1	0	1	1	0	0	1	1.05625	59
0	1	0	1	1	0	1	0	1.05000	5A
0	1	0	1	1	0	1	1	1.04375	5B
0	1	0	1	1	1	0	0	1.03750	5C
0	1	0	1	1	1	0	1	1.03125	5D
0	1	0	1	1	1	1	0	1.02500	5E
0	1	0	1	1	1	1	1	1.01875	5F
0	1	1	0	0	0	0	0	1.01250	60
0	1	1	0	0	0	0	1	1.00625	61
0	1	1	0	0	0	1	0	1.00000	62
0	1	1	0	0	0	1	1	0.99375	63
0	1	1	0	0	1	0	0	0.98750	64
0	1	1	0	0	1	0	1	0.98125	65
0	1	1	0	0	1	1	0	0.97500	66
0	1	1	0	0	1	1	1	0.96875	67
0	1	1	0	1	0	0	0	0.96250	68
0	1	1	0	1	0	0	1	0.95625	69
0	1	1	0	1	0	1	0	0.95000	6A
0	1	1	0	1	0	1	1	0.94375	6B
0	1	1	0	1	1	0	0	0.93750	6C
0	1	1	0	1	1	0	1	0.93125	6D
0	1	1	0	1	1	1	0	0.92500	6E
0	1	1	0	1	1	1	1	0.91875	6F
0	1	1	1	0	0	0	0	0.91250	70
0	1	1	1	0	0	0	1	0.90625	71
0	1	1	1	0	0	1	0	0.90000	72
0	1	1	1	0	0	1	1	0.89375	73
0	1	1	1	0	1	0	0	0.88750	74
0	1	1	1	0	1	0	1	0.88125	75
0	1	1	1	0	1	1	0	0.87500	76
0	1	1	1	0	1	1	1	0.86875	77
0	1	1	1	1	0	0	0	0.86250	78
0	1	1	1	1	0	0	1	0.85625	79
0	1	1	1	1	0	1	0	0.85000	7A
0	1	1	1	1	0	1	1	0.84375	7B
0	1	1	1	1	1	0	0	0.83750	7C
0	1	1	1	1	1	0	1	0.83125	7D
0	1	1	1	1	1	1	0	0.82500	7E
0	1	1	1	1	1	1	1	0.81875	7F
1	0	0	0	0	0	0	0	0.81250	80

Table 1: VRM11 VID Codes

VID7 800 mV	VID6 400 mV	VID5 200 mV	VID4 100 mV	VID3 50 mV	VID2 25 mV	VID1 12.5 mV	VID0 6.25 mV	Voltage (V)	HEX
1	0	0	0	0	0	0	1	0.80625	81
1	0	0	0	0	0	1	0	0.80000	82
1	0	0	0	0	0	1	1	0.79375	83
1	0	0	0	0	1	0	0	0.78750	84
1	0	0	0	0	1	0	1	0.78125	85
1	0	0	0	0	1	1	0	0.77500	86
1	0	0	0	0	1	1	1	0.76875	87
1	0	0	0	1	0	0	0	0.76250	88
1	0	0	0	1	0	0	1	0.75625	89
1	0	0	0	1	0	1	0	0.75000	8A
1	0	0	0	1	0	1	1	0.74375	8B
1	0	0	0	1	1	0	0	0.73750	8C
1	0	0	0	1	1	0	1	0.73125	8D
1	0	0	0	1	1	1	0	0.72500	8E
1	0	0	0	1	1	1	1	0.71875	8F
1	0	0	1	0	0	0	0	0.71250	90
1	0	0	1	0	0	0	1	0.70625	91
1	0	0	1	0	0	1	0	0.70000	92
1	0	0	1	0	0	1	1	0.69375	93
1	0	0	1	0	1	0	0	0.68750	94
1	0	0	1	0	1	0	1	0.68125	95
1	0	0	1	0	1	1	0	0.67500	96
1	0	0	1	0	1	1	1	0.66875	97
1	0	0	1	1	0	0	0	0.66250	98
1	0	0	1	1	0	0	1	0.65625	99
1	0	0	1	1	0	1	0	0.65000	9A
1	0	0	1	1	0	1	1	0.64375	9B
1	0	0	1	1	1	0	0	0.63750	9C
1	0	0	1	1	1	0	1	0.63125	9D
1	0	0	1	1	1	1	0	0.62500	9E
1	0	0	1	1	1	1	1	0.61875	9F
1	0	1	0	0	0	0	0	0.61250	A0
1	0	1	0	0	0	0	1	0.60625	A1
1	0	1	0	0	0	1	0	0.60000	A2
1	0	1	0	0	0	1	1	0.59375	A3
1	0	1	0	0	1	0	0	0.58750	A4
1	0	1	0	0	1	0	1	0.58125	A5
1	0	1	0	0	1	1	0	0.57500	A6
1	0	1	0	0	1	1	1	0.56875	A7
1	0	1	0	1	0	0	0	0.56250	A8
1	0	1	0	1	0	0	1	0.55625	A9
1	0	1	0	1	0	1	0	0.55000	AA
1	0	1	0	1	0	1	1	0.54375	AB
1	0	1	0	1	1	0	0	0.53750	AC
1	0	1	0	1	1	0	1	0.53125	AD
1	0	1	0	1	1	1	0	0.52500	AE

Table 1: VRM11 VID Codes

VID7 800 mV	VID6 400 mV	VID5 200 mV	VID4 100 mV	VID3 50 mV	VID2 25 mV	VID1 12.5 mV	VID0 6.25 mV	Voltage (V)	HEX
1	0	1	0	1	1	1	1	0.51875	AF
1	0	1	1	0	0	0	0	0.51250	B0
1	0	1	1	0	0	0	1	0.50625	B1
1	0	1	1	0	0	1	0	0.50000	B2
1	1	1	1	1	1	1	0	OFF	FE
1	1	1	1	1	1	1	1	OFF	FF
								OFF	B3 to FD

NCP5387

ELECTRICAL CHARACTERISTICS
(Unless otherwise stated: 0°C < T_A < 85°C; 4.75 V < V_{CC} < 5.25 V; All DAC Codes; C_{VCC} = 0.1 μF)

Parameter	Test Conditions	Min	Typ	Max	Units
VRM10 DAC					
System Voltage Accuracy	1.0 V < DAC < 1.6 V 0.83125 V < DAC < 1.0 V	– 	– 	±0.5 ±5	% mV
No Load Offset Voltage from Nominal DAC Specification	With CS Input ΔV_{in} = 0 V	–	−19	–	mV

Table 2: VRM10 VID Codes

VID4 400 mV	VID3 200 mV	VID2 100 mV	VID1 50 mV	VID0 25 mV	VID5 12.5 mV	VID6 6.25 mV	Nominal DAC Voltage (V)
0	1	0	1	0	1	1	1.60000
0	1	0	1	0	1	0	1.59375
0	1	0	1	1	0	1	1.58750
0	1	0	1	1	0	0	1.58125
0	1	0	1	1	1	1	1.57500
0	1	0	1	1	1	0	1.56875
0	1	1	0	0	0	1	1.56250
0	1	1	0	0	0	0	1.55625
0	1	1	0	0	1	1	1.55000
0	1	1	0	0	1	0	1.54375
0	1	1	0	1	0	1	1.53750
0	1	1	0	1	0	0	1.53125
0	1	1	0	1	1	1	1.52500
0	1	1	0	1	1	0	1.51875
0	1	1	1	0	0	1	1.51250
0	1	1	1	0	0	0	1.50625
0	1	1	1	0	1	1	1.50000
0	1	1	1	0	1	0	1.49375
0	1	1	1	1	0	1	1.48750
0	1	1	1	1	0	0	1.48125
0	1	1	1	1	1	1	1.47500
0	1	1	1	1	1	0	1.46875
1	0	0	0	0	0	1	1.46250
1	0	0	0	0	0	0	1.45625
1	0	0	0	0	1	1	1.45000
1	0	0	0	0	1	0	1.44375
1	0	0	0	1	0	1	1.43750
1	0	0	0	1	0	0	1.43125
1	0	0	0	1	1	1	1.42500
1	0	0	0	1	1	0	1.41875
1	0	0	1	0	0	1	1.41250
1	0	0	1	0	0	0	1.40625
1	0	0	1	0	1	1	1.40000
1	0	0	1	0	1	0	1.39375
1	0	0	1	1	0	1	1.38750
1	0	0	1	1	0	0	1.38125
1	0	0	1	1	1	1	1.37500
1	0	0	1	1	1	0	1.36875

Table 2: VRM10 VID Codes

VID4 400 mV	VID3 200 mV	VID2 100 mV	VID1 50 mV	VID0 25 mV	VID5 12.5 mV	VID6 6.25 mV	Nominal DAC Voltage (V)
1	0	1	0	0	0	1	1.36250
1	0	1	0	0	0	0	1.35625
1	0	1	0	0	1	1	1.35000
1	0	1	0	0	1	0	1.34375
1	0	1	0	1	0	1	1.33750
1	0	1	0	1	0	0	1.33125
1	0	1	0	1	1	1	1.32500
1	0	1	0	1	1	0	1.31875
1	0	1	1	0	0	1	1.31250
1	0	1	1	0	0	0	1.30625
1	0	1	1	0	1	1	1.30000
1	0	1	1	0	1	0	1.29375
1	0	1	1	1	0	1	1.28750
1	0	1	1	1	0	0	1.28125
1	0	1	1	1	1	1	1.27500
1	0	1	1	1	1	0	1.26875
1	1	0	0	0	0	1	1.26250
1	1	0	0	0	0	0	1.25625
1	1	0	0	0	1	1	1.25000
1	1	0	0	0	1	0	1.24375
1	1	0	0	1	0	1	1.23750
1	1	0	0	1	0	0	1.23125
1	1	0	0	1	1	1	1.22500
1	1	0	0	1	1	0	1.21875
1	1	0	1	0	0	1	1.21250
1	1	0	1	0	0	0	1.20625
1	1	0	1	0	1	1	1.20000
1	1	0	1	0	1	0	1.19375
1	1	0	1	1	0	1	1.18750
1	1	0	1	1	0	0	1.18125
1	1	0	1	1	1	1	1.17500
1	1	0	1	1	1	0	1.16875
1	1	1	0	0	0	1	1.16250
1	1	1	0	0	0	0	1.15625
1	1	1	0	0	1	1	1.15000
1	1	1	0	0	1	0	1.14375
1	1	1	0	1	0	1	1.13750
1	1	1	0	1	0	0	1.13125
1	1	1	0	1	1	1	1.12500
1	1	1	0	1	1	0	1.11875
1	1	1	1	0	0	1	1.11250
1	1	1	1	0	0	0	1.10625
1	1	1	1	0	1	1	1.10000
1	1	1	1	0	1	0	1.09375
1	1	1	1	1	0	1	OFF
1	1	1	1	1	0	0	OFF
1	1	1	1	1	1	1	OFF

Table 2: VRM10 VID Codes

VID4 400 mV	VID3 200 mV	VID2 100 mV	VID1 50 mV	VID0 25 mV	VID5 12.5 mV	VID6 6.25 mV	Nominal DAC Voltage (V)
1	1	1	1	1	1	0	OFF
0	0	0	0	0	0	1	1.08750
0	0	0	0	0	0	0	1.08125
0	0	0	0	0	1	1	1.07500
0	0	0	0	0	1	0	1.06875
0	0	0	0	1	0	1	1.06250
0	0	0	0	1	0	0	1.05625
0	0	0	0	1	1	1	1.05000
0	0	0	0	1	1	0	1.04375
0	0	0	1	0	0	1	1.03750
0	0	0	1	0	0	0	1.03125
0	0	0	1	0	1	1	1.02500
0	0	0	1	0	1	0	1.01875
0	0	0	1	1	0	1	1.01250
0	0	0	1	1	0	0	1.00625
0	0	0	1	1	1	1	1.00000
0	0	0	1	1	1	0	0.99375
0	0	1	0	0	0	1	0.98750
0	0	1	0	0	0	0	0.98125
0	0	1	0	0	1	1	0.97500
0	0	1	0	0	1	0	0.96875
0	0	1	0	1	0	1	0.96250
0	0	1	0	1	0	0	0.95625
0	0	1	0	1	1	1	0.95000
0	0	1	0	1	1	0	0.94375
0	0	1	1	0	0	1	0.93750
0	0	1	1	0	0	0	0.93125
0	0	1	1	0	1	1	0.92500
0	0	1	1	0	1	0	0.91875
0	0	1	1	1	0	1	0.91250
0	0	1	1	1	0	0	0.90625
0	0	1	1	1	1	1	0.90000
0	0	1	1	1	1	0	0.89375
0	1	0	0	0	0	1	0.88750
0	1	0	0	0	0	0	0.88125
0	1	0	0	0	1	1	0.87500
0	1	0	0	0	1	0	0.86875
0	1	0	0	1	0	1	0.86250
0	1	0	0	1	0	0	0.85625
0	1	0	0	1	1	1	0.85000
0	1	0	0	1	1	0	0.84375
0	1	0	1	0	0	1	0.83750
0	1	0	1	0	0	0	0.83125

NCP5387

ELECTRICAL CHARACTERISTICS

(Unless otherwise stated: $0°C < T_A < 85°C$; $4.75 V < V_{CC} < 5.25 V$; All DAC Codes; $C_{VCC} = 0.1 \mu F$)

Parameter	Test Conditions	Min	Typ	Max	Units
AMD DAC					
System Voltage Accuracy	1.0 V < DAC < 1.55 V 0.8 V < DAC < 1.0 V	– 	– 	±0.5 ±5.0	% mV
No Load Offset Voltage from Nominal DAC Specification	With CS Input $\Delta V_{in} = 0$ V	–	0	–	mV

Table 3: AMD VID Codes

VID4	VID3	VID2	VID1	VID0	Nominal V_{OUT} (V)	Tolerance
0	0	0	0	0	1.550	±0.5 %
0	0	0	0	1	1.525	±0.5 %
0	0	0	1	0	1.500	±0.5 %
0	0	0	1	1	1.475	±0.5 %
0	0	1	0	0	1.450	±0.5 %
0	0	1	0	1	1.425	±0.5 %
0	0	1	1	0	1.400	±0.5 %
0	0	1	1	1	1.375	±0.5 %
0	1	0	0	0	1.350	±0.5 %
0	1	0	0	1	1.325	±0.5 %
0	1	0	1	0	1.300	±0.5 %
0	1	0	1	1	1.275	±0.5 %
0	1	1	0	0	1.250	±0.5 %
0	1	1	0	1	1.225	±0.5 %
0	1	1	1	0	1.200	±0.5 %
0	1	1	1	1	1.175	±0.5 %
1	0	0	0	0	1.150	±0.5 %
1	0	0	0	1	1.125	±0.5 %
1	0	0	1	0	1.100	±0.5 %
1	0	0	1	1	1.075	±0.5 %
1	0	1	0	0	1.050	±0.5 %
1	0	1	0	1	1.025	±0.5 %
1	0	1	1	0	1.000	±0.5 %
1	0	1	1	1	0.975	±5.0 mV
1	1	0	0	0	0.950	±5.0 mV
1	1	0	0	1	0.925	±5.0 mV
1	1	0	1	0	0.900	±5.0 mV
1	1	0	1	1	0.875	±5.0 mV
1	1	1	0	0	0.850	±5.0 mV
1	1	1	0	1	0.825	±5.0 mV
1	1	1	1	0	0.800	±5.0 mV
1	1	1	1	1	Shutdown	–

TYPICAL CHARACTERISTICS
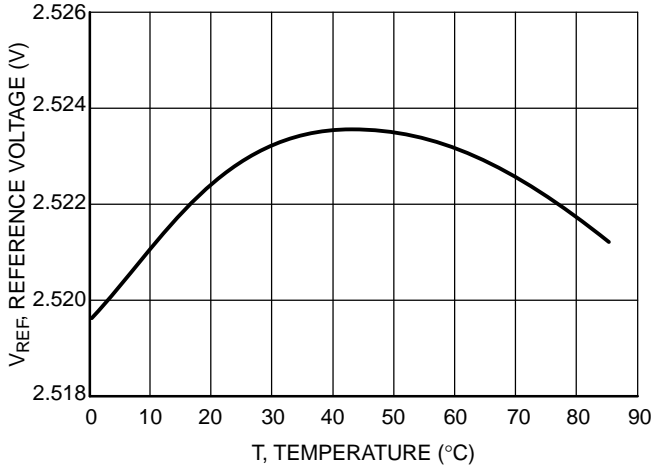
Figure 5. Voltage Reference (VREF) vs. Temperature
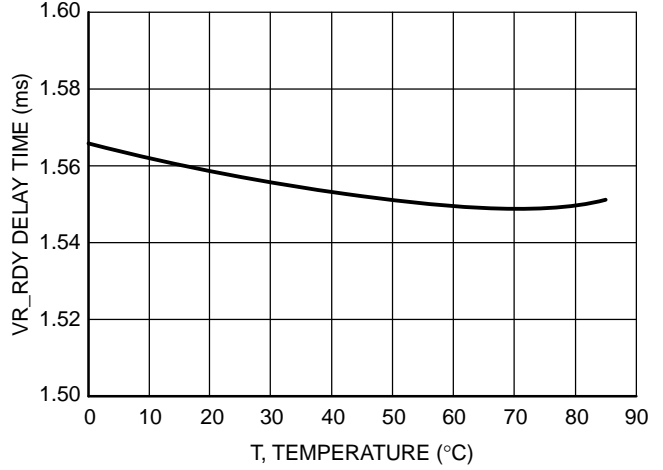
Figure 6. VR Ready Delay Time vs. Temperature
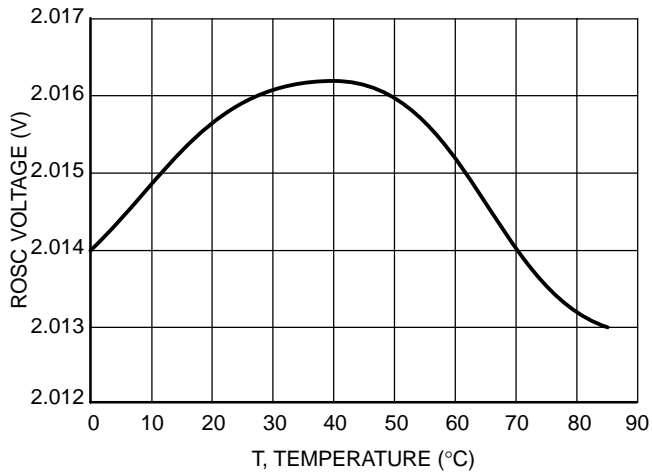
Figure 7. ROSC Voltage vs. Temperature
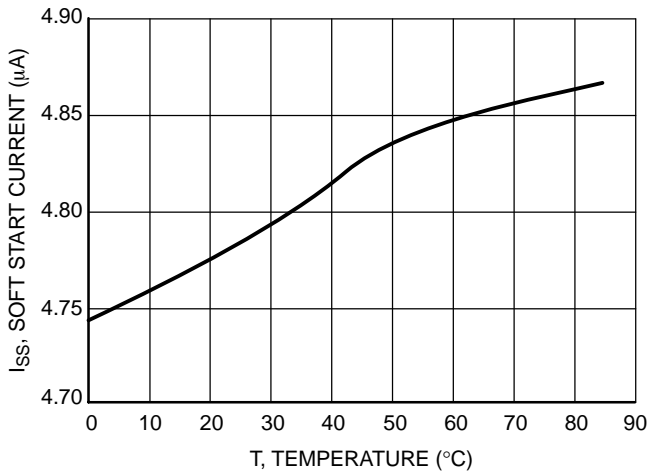
Figure 8. Soft Start Current vs. Temperature
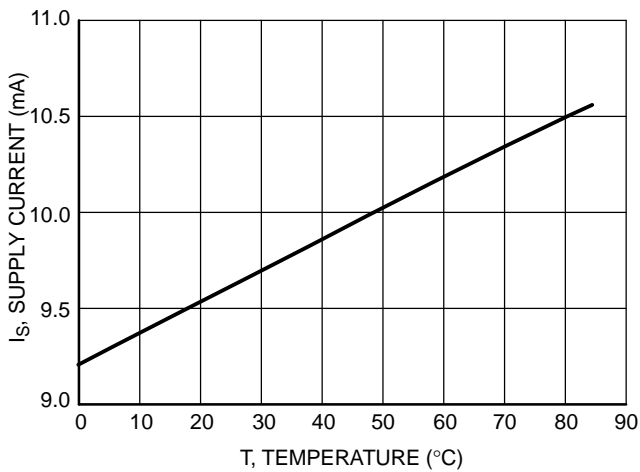
Figure 9. Supply Current vs. Temperature
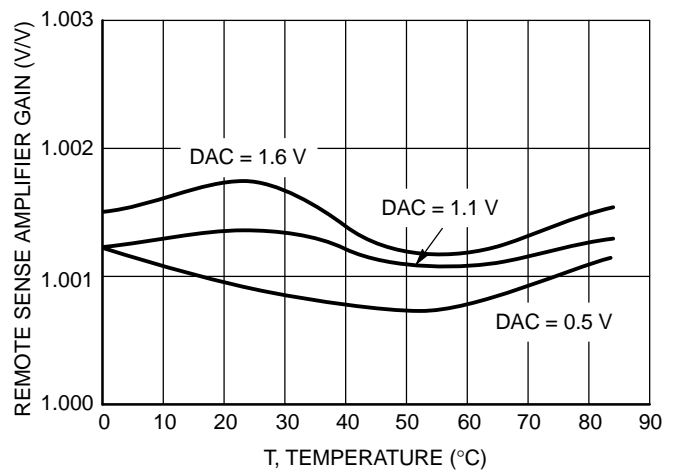
Figure 10. Remote Sense Amplifier Gain vs. Temperature

NCP5387

TYPICAL CHARACTERISTICS

Figure 11. UVLO Threshold vs. Temperature
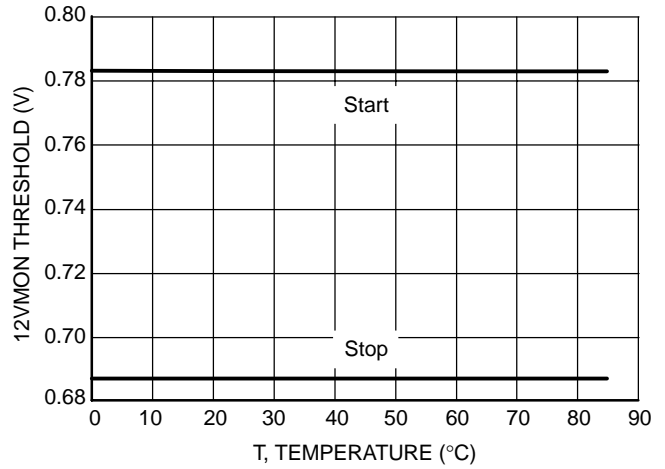
Figure 12. 12VMON Threshold vs. Temperature
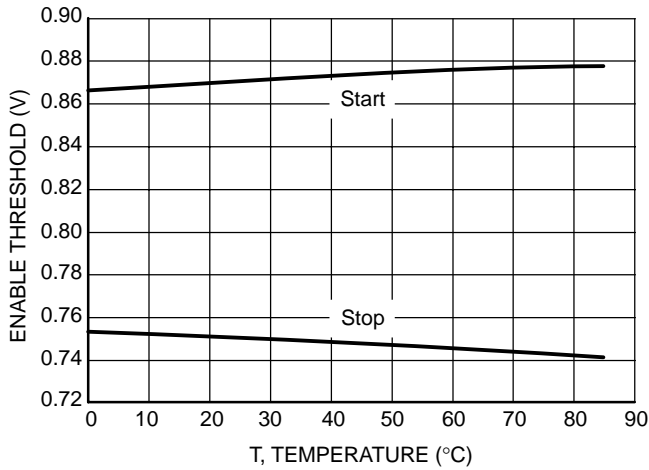
Figure 13. Enable Threshold vs. Temperature
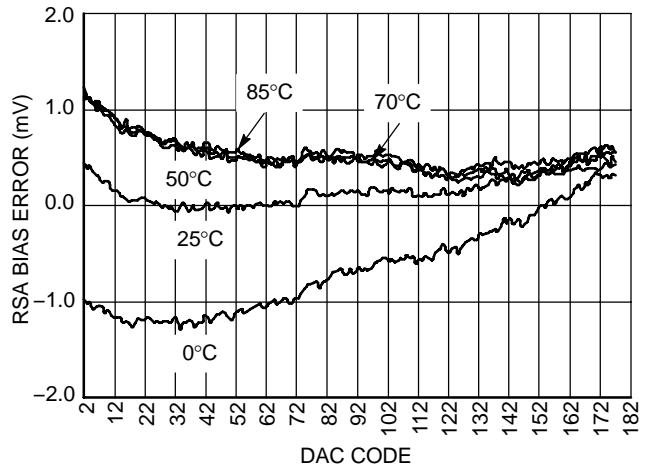
Figure 14. Remote Sense Amplifier Bias Error vs. DAC Code
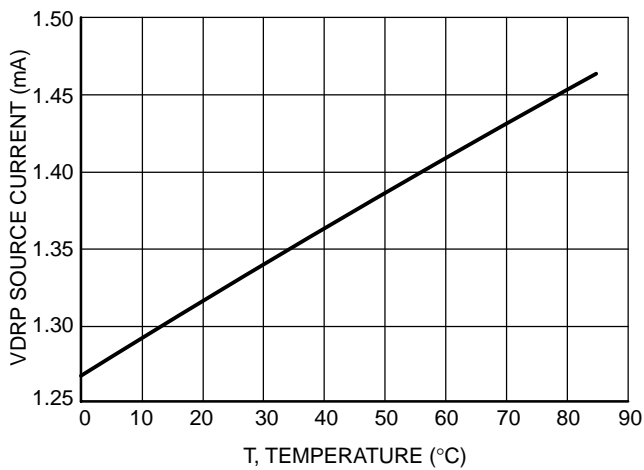
Figure 15. VDRP Source Current vs. Temperature
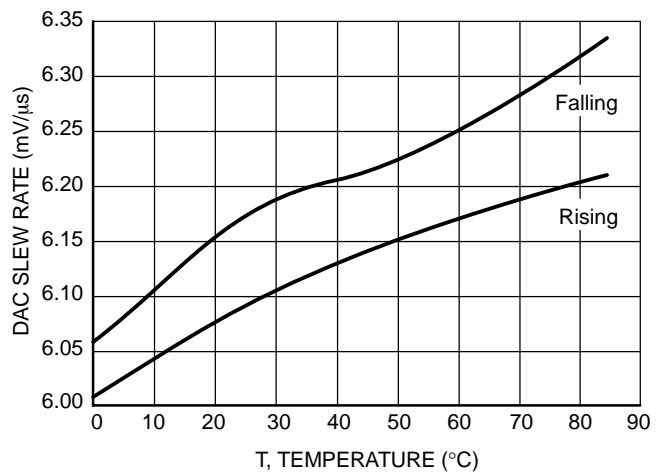
Figure 16. DAC Slew Rate vs. Temperature

NCP5387

TYPICAL CHARACTERISTICS

Figure 17. VDRP Gain vs. Temperature
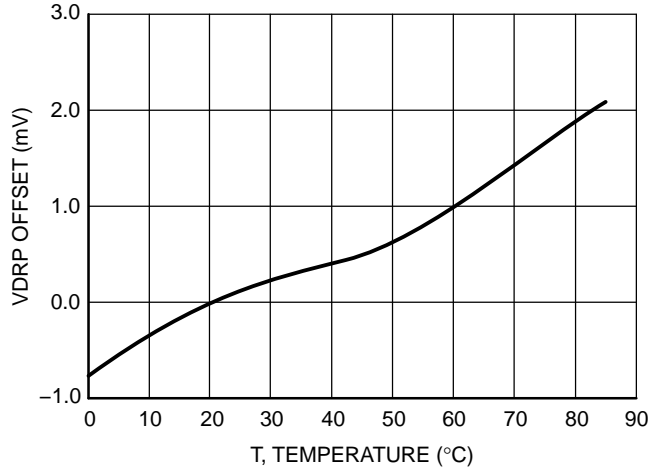
Figure 18. VDRP Offset vs. Temperature
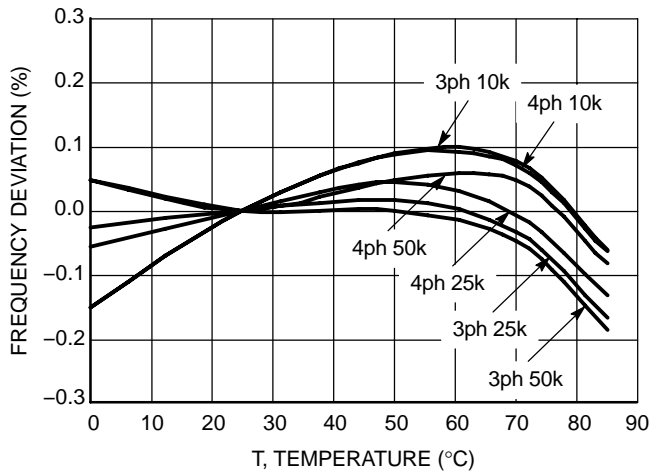
Figure 19. Switching Frequency Deviation vs. Temperature
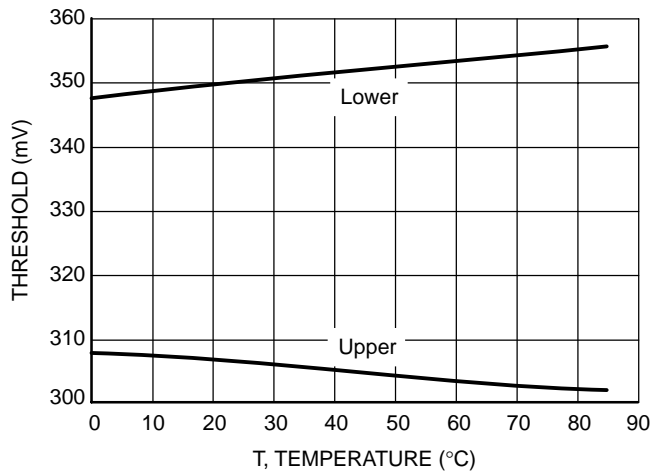
Figure 20. VR_RDY Thresholds vs. Temperature
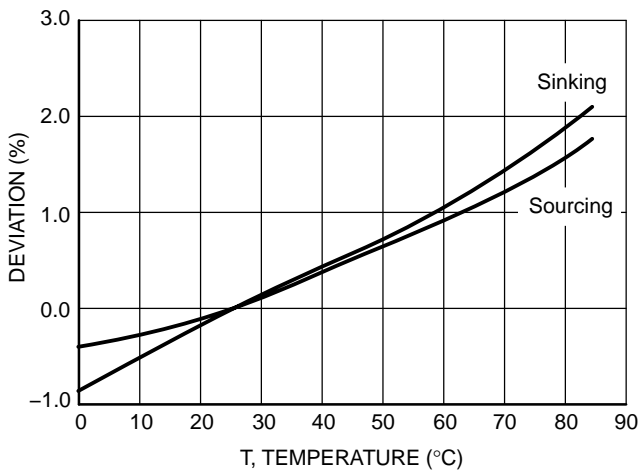
Figure 21. PWM Output Resistance Deviation vs. Temperature
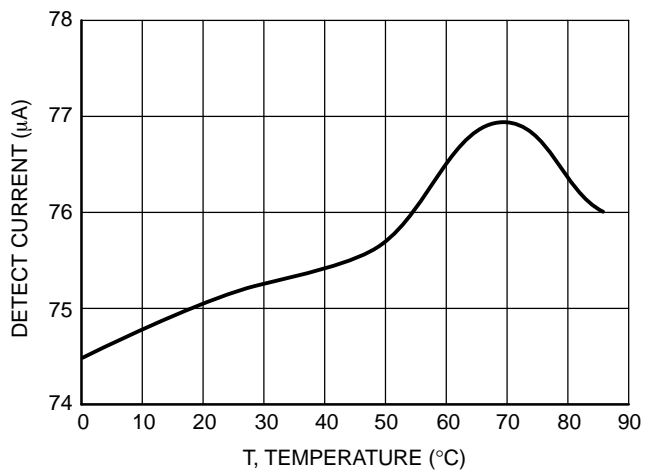
Figure 22. 2/3/4 Phase Detect Current vs. Temperature

TYPICAL CHARACTERISTICS
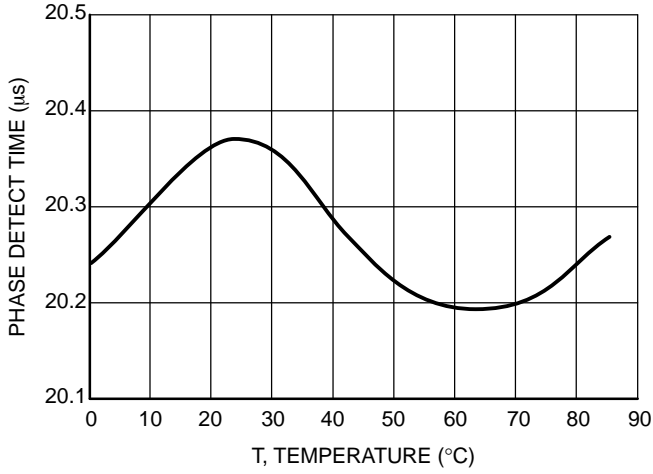
Figure 23. Phase Detect Time vs. Temperature
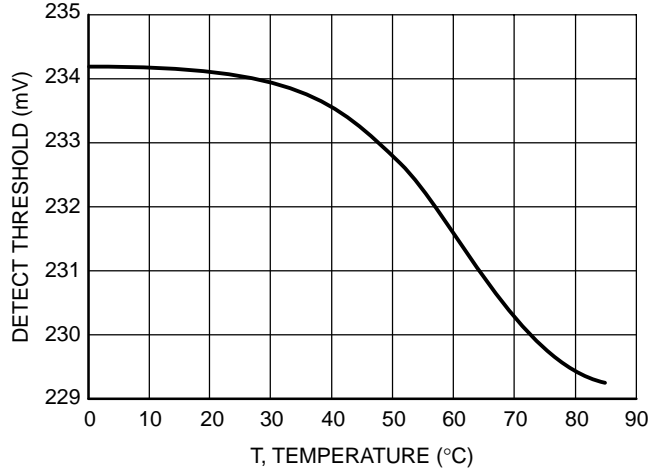
Figure 24. 2/3/4 Phase Detect Threshold vs. Temperature

FUNCTIONAL DESCRIPTION

General

The NCP5387 dual edge modulated multiphase PWM controller is specifically designed with the necessary features for a high current VR10, VR11 or AMD CPU power system. The IC consists of the following blocks: Precision Programmable DAC, Differential Remote Voltage Sense Amplifier, High Performance Voltage Error Amplifier, Differential Current Feedback Amplifiers, Precision Oscillator and Triangle Wave Generators, and PWM Comparators. Protection features include Undervoltage Lockout, Soft−Start, Overcurrent Protection, Overvoltage Protection, and Power Good Monitor.

Remote Output Sensing Amplifier (RSA)

A true differential amplifier allows the NCP5387 to measure Vcore voltage feedback with respect to the Vcore ground reference point by connecting the Vcore reference point to VS+, and the Vcore ground reference point to VS−. This configuration keeps ground potential differences between the local controller ground and the Vcore ground reference point from affecting regulation of Vcore between Vcore and Vcore ground reference points. The RSA also subtracts the DAC (minus VID offset) voltage, thereby producing an unamplified output error voltage at the DIFFOUT pin. This output also has a 1.3 V bias voltage to allow both positive and negative error voltages.

Precision Programmable DAC

A precision programmable DAC is provided. This DAC has 0.5% accuracy over the entire operating temperature range of the part. The DAC can be programmed to support either Intel VR10 or VR11 or AMD K8 specifications. A program selection pin is provided to accomplish this. This pin also sets the startup mode of operation. Connect this pin to 1.25 V to select the VR11 DAC table and startup mode. Connect this pin to ground to select the VR10 DAC table and the VR11 startup mode. Connect this pin to VREF to select the AMD DAC table and startup mode.

High Performance Voltage Error Amplifier

The error amplifier is designed to provide high slew rate and bandwidth. Although not required when operating as the controller of a voltage regulator, a capacitor from COMP to VFB is required for stable unity gain test configurations.

Gate Driver Outputs and 2/3/4 Phase Operation

The part can be configured to run in 2−, 3−, or 4−phase mode. In 2−phase mode, phases 1 and 3 should be used to drive the external gate drivers as shown in the 2−phase Applications Schematic. In 3−phase mode, gate output G4 must be grounded as shown in the 3−phase Applications Schematic. In 4−phase mode all 4 gate outputs are used as shown in the 4−phase Applications Schematic. The Current Sense inputs of unused channels should be connected to CSN of a channel that is used. The following truth table summarizes the modes of operation:

Mode	Gate Output Connections			
	G1	**G2**	**G3**	**G4**
2−Phase	Normal	**OPEN**	Normal	**OPEN**
3−Phase	Normal	Normal	Normal	**GND**
4−Phase	Normal	Normal	Normal	Normal

These are the only allowable connection schemes to program the modes of operation.

Differential Current Sense Amplifiers

Four differential amplifiers are provided to sense the output current of each phase. The inputs of each current sense amplifier must be connected across the current sensing element of the phase controlled by the corresponding gate output (G1, G2, G3, or G4). **If a phase is unused, the differential inputs to that phase's current sense amplifier must be shorted together and connected to the output as shown in the 2− and 3−phase Application Schematics**.

A voltage is generated across the current sense element (such as an inductor or sense resistor) by the current flowing in that phase. The output of the current sense amplifiers are used to control three functions. First, the output controls the adaptive voltage positioning, where the output voltage is actively controlled according to the output current. In this function, all of the current sense outputs are summed so that the total output current is used for output voltage positioning. Second, the output signal is fed to the current limit circuit. This again is the summed current of all phases in operation. Finally, the individual phase current is connected to the PWM comparator. In this way current balance is accomplished.

Oscillator and Triangle Wave Generator

A programmable precision oscillator is provided. The oscillator's frequency is programmed by the resistance connected from the ROSC pin to ground. The user will usually form this resistance from two resistors in order to create a voltage divider that uses the ROSC output voltage as the reference for creating the current limit setpoint voltage. The oscillator frequency range is 100 kHz/phase to 1.0 MHz/phase. The oscillator generates up to 4 triangle waveforms (symmetrical rising and falling slopes) between 1.3 V and 2.3 V. The triangle waves have a phase delay between them such that for 2−, 3−, and 4−phase operation the PWM outputs are separated by 180, 120, and 90 angular degrees, respectively.

NCP5387

PWM Comparators with Hysteresis

Four PWM comparators receive the error amplifier output signal at their noninverting input. Each comparator receives one of the triangle waves offset by 1.3 V at it's inverting input. The output of the comparator generates the PWM outputs G1, G2, G3, and G4.

During steady state operation, the duty cycle will center on the valley of the triangle waveform, with steady state duty cycle calculated by V_{out}/V_{in}. During a transient event, both high and low comparator output transitions shift phase to the points where the error amplifier output intersects the down and up ramp of the triangle wave.

PROTECTION FEATURES

Undervoltage Lockout

An undervoltage lockout (UVLO) senses the V_{CC} input. During powerup, the input voltage to the controller is monitored, and the PWM outputs and the soft−start circuit are disabled until the input voltage exceeds the threshold voltage of the UVLO comparator. The UVLO comparator incorporates hysteresis to avoid chattering, since V_{CC} is likely to decrease as soon as the converter initiates soft−start.

Overcurrent Shutdown

A programmable overcurrent function is incorporated within the IC. A comparator and latch make up this function. The inverting input of the comparator is connected to the ILIM pin. The voltage at this pin sets the maximum output current the converter can produce. The ROSC pin provides a convenient and accurate reference voltage from which a resistor divider can create the overcurrent setpoint voltage. Although not actually disabled, tying the ILIM pin directly to the ROSC pin sets the limit above useful levels – effectively disabling overcurrent shutdown. The comparator noninverting input is the summed current information from the current sense

amplifiers. The overcurrent latch is set when the current information exceeds the voltage at the ILIM pin. The outputs are immediately disabled, the VR_RDY and DRVON pins are pulled low, and the soft−start is pulled low. The outputs will remain disabled until the V_{CC} voltage is removed and re−applied, or the ENABLE input is brought low and then high.

Overvoltage Protection and Power Good Monitor

An output voltage monitor is incorporated. During normal operation, if the voltage at the DIFFOUT pin exceeds 1.5 V, the VR_RDY pin goes low, the DRVON signal remains high, the PWM outputs are set low. The outputs will remain disabled until the V_{CC} voltage is removed and reapplied. During normal operation, if the output voltage falls more than 350 mV below the DAC setting, the VR_RDY pin will be set low until the output rises.

Soft−Start

The NCP5387 incorporates an externally programmable soft−start. The soft−start circuit works by controlling the ramp−up of the DAC voltage during powerup. The initial soft−start pin voltage is 0 V. The soft−start circuitry clamps the DAC input of the Remote Sense Amplifier to the SS pin voltage until the SS pin voltage exceeds the DAC setting minus VID offset. Thereafter, the soft−start pin is pulled to 0 V.

There are two possible soft−start modes: AMD and VR11. AMD mode simply ramps Vcore from 0 V directly to the DAC setting at the rate set by the capacitor connected to the SS pin. The VR11 mode ramps Vcore to 1.1 V at the SS capacitor charge rate, pauses at 1.1 V for 170 μs, reads the VID pins to determine the DAC setting, then ramps Vcore to the final DAC setting at the Dynamic VID slew rate of 6.3 mV/μs. Typical AMD and VR11 soft−start sequences are shown in the following graphs.
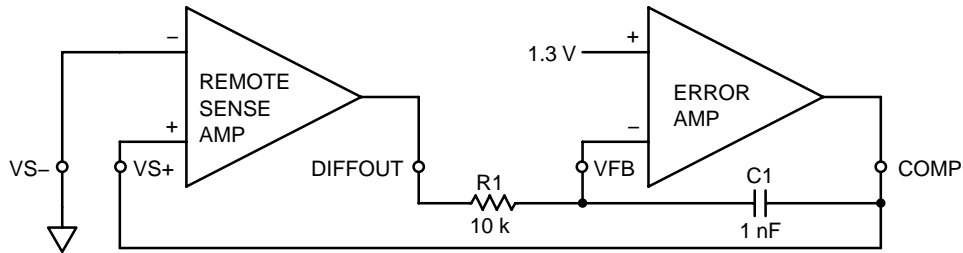
Figure 25. DAC Servo Evaluation Circuit
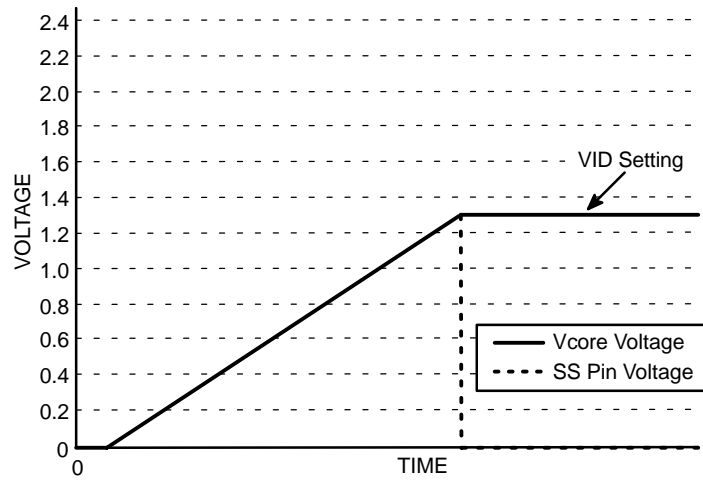
Figure 26. Typical AMD Soft−Start Sequence to Vcore = 1.3 V
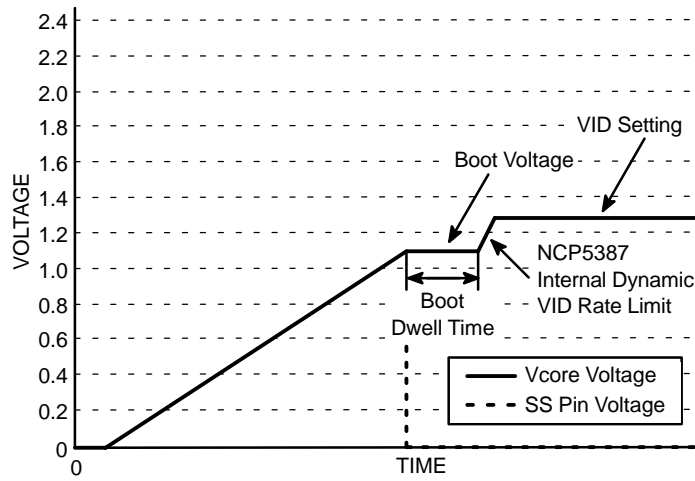
Figure 27. Typical VR10 & VR11 Soft−Start Sequence to Vcore = 1.3 V

NCP5387

APPLICATION INFORMATION

The NCP5387 is a high performance multiphase controller optimized to meet the Intel VR11 Specifications. The demo board for the NCP5387 is available by request. It is configured as a four phase solution with decoupling designed to provide a 1.0 mΩ load line under a 100 A step load. A schematic is available upon request from ON Semiconductor.

Startup Procedure

The demo board comes with a Socket 775 and requires an Intel dynamic load tool (VTT Tool) available through a third party supplier, Cascade Systems. The web page is http://www.cascadesystems.net/.

Start by installing the test tool software. It's best to power the test tool from a separate ATX power supply. The test tool should be set to a valid VID code of 0.5 V or above in−order for the controller to start. Consult the VTT help manual for more detailed instructions.

Startup Sequence

1. Make sure the VTT software is installed.
2. Powerup the PC or Laptop do not start the VTT software.
3. Insert the VTT Test Tool adapter into the socket and lock it down.
4. Inset the socket saver pin field into the bottom of the VTT test tool.
5. Carefully line up the tool with the socket in the board and press tool into the board.
6. Connect the scope probe, or DMM to the voltage sense lines on the test tool. When using a scope probe it is best to isolate the scope from the AC ground. Make the ground connection on the scope probe as short as possible.
7. Connect the first ATX supply to the VTT tool.
8. Powerup the first ATX supply to the VTT tool.
9. Start the VTT tool software in VR11 mode with the current limit set to 150 A.
10. Using the VTT tool software, select a VID code that is 0.5 V or above.
11. Connect the second ATX supply to the demo board.
12. Set the VID DIP switches. All the VID switches should be up or open.
13. Set the ENABLE DIP switch down or closed.
14. Set the VR10 DIP switch up or open.
15. Set the VID_SEL switch up or open.

16. Start the second ATX supply by turning it on and setting the PSON DIP switch low. The green VID lights should light up to match the VTT tool VID setting.
17. Set the ENABLE DIP switch up to start the NCP5387.
18. Check that the output voltage is about 19 mV below the VID setting.

Step Load Testing

The VTT tool is used to generate the high di/dt step load. Select the dynamic loading option in the VTT test tool software. Set the desired step load size, frequency, duty, and slew rate. See Figures 28 and 29.
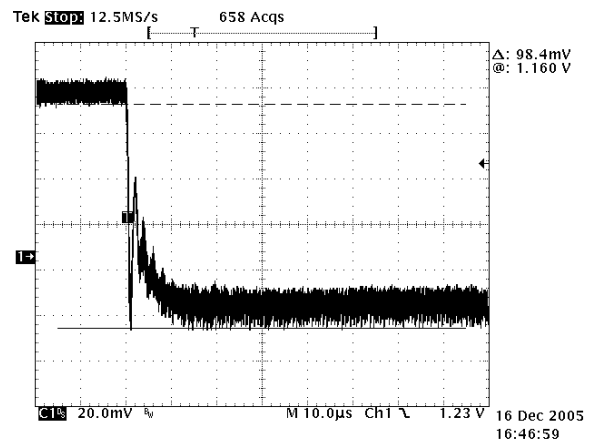
Figure 28. Typical Step Load Response
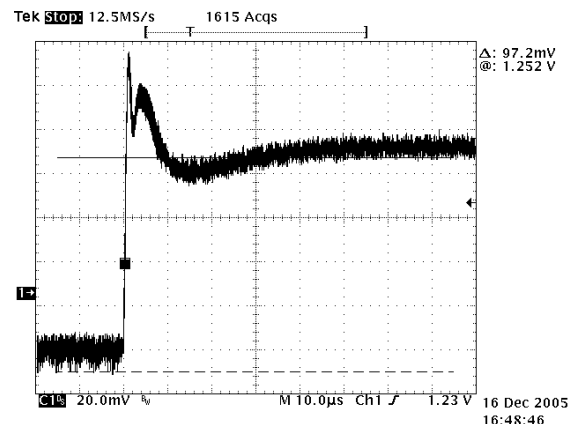
Figure 29. Typical Load Release Event

Dynamic VID Testing

The VTT tool provides for VID stepping based on the Intel Requirements. Select the Dynamic VID option. Before enabling the test set the lowest VID to 0.5 V or greater and set the highest VID to a value that is greater than the lowest VID selection, then enable the test. See Figures 30 through 32.
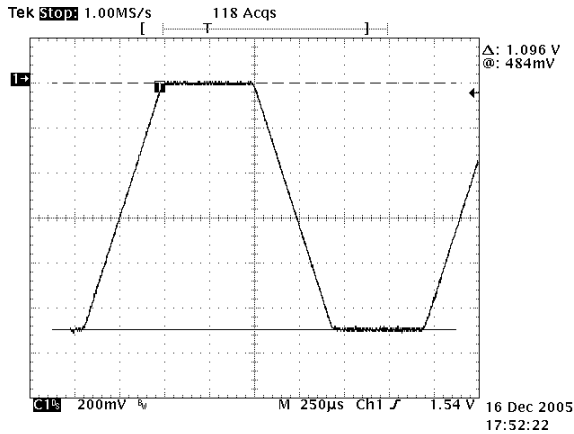
Figure 30. 1.6 to 0.5 Dynamic VID Response
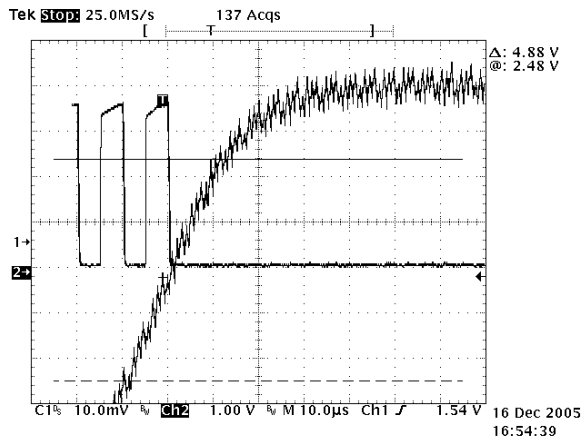
Figure 31. Dynamic VID Settling Time Rising
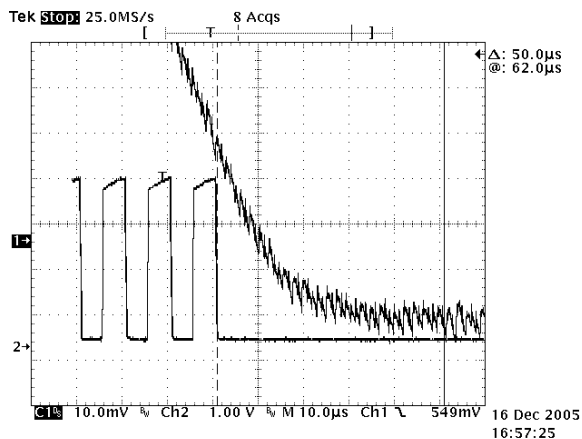
Figure 32. Dynamic VID Settling Time Falling

Design Methodology

Decoupling the V_{CC} Pin on the IC

An RC input filter is required as shown in the V_{CC} pin to minimize supply noise on the IC. The resistor should be sized such that it does not generate a large voltage drop between the 5 V supply and the IC.

Understanding Soft–Start

The controller supports two different startup routines. An AMD ramp to the initial VID code, or a VR11 Ramp to the 1.1 V VID code, with a pause to capture the VID code then resume ramping to target value based on an internal slew rate limit. See Figures 33 and 34. The controller is designed to regulate to the voltage on the SS pin until it reaches the internal DAC voltage. The soft–start cap sets the initial ramp rate using a typical 5.0 μA current. The typical value to use for the soft–start cap (SS) is 0.01 μF. This results in a ramp time to 1.1 V of 2.2 ms based on equation 1.

$$C_{SS} \cong i_{SS}\frac{dt_{SS}}{dv_{SS}}$$

$$\frac{1.1 \cdot V}{2.2 \cdot ms} = \frac{dv_{SS}}{dt_{SS}} \text{ and } i_{SS} = 5 \cdot \mu A \qquad \text{(eq. 1)}$$

$$C_{SS} = 0.01 \cdot \mu F$$
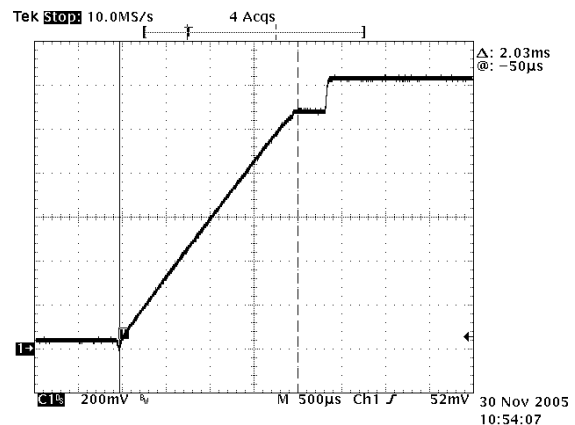
Figure 33. VR11 Startup
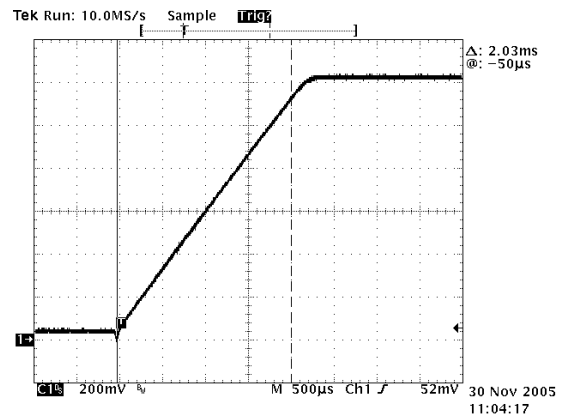
Figure 34. AMD Startup

Programming the Current Limit and the Oscillator Frequency

The demo board is set for an operating frequency of approximately 330 kHz. The ROSC pin provides a 2.0 V reference voltage which is divided down with a resistor divider and fed into the current limit pin ILIM. Calculate the total series resistance to set the frequency and then calculate the individual RLIM1 and RLIM2 values for the divider.

The series resistors RLIM1 and RLIM2 sink current from the ILIM pin to ground. This current is internally mirrored into a capacitor to create an oscillator. The period is proportional to the resistance and frequency is inversely proportional to the total resistance. The total resistance may be estimated by equation 2. This equation is valid for the individual phase frequency in both three and four phase mode.

$$R_{TOTAL} \cong 24686 \times F_{sw}^{-1.1549}$$

(eq. 2)

$$30.5 \cdot k\Omega \cong 24686 \times 330^{-1.1549}$$
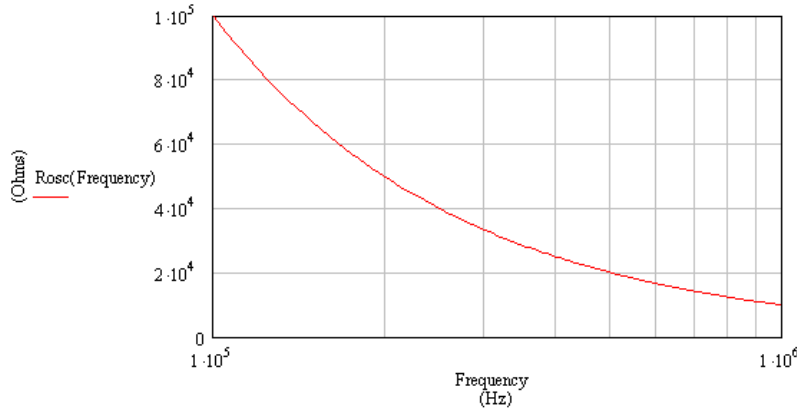
Figure 35.

The current limit function is based on the total sensed current of all phases multiplied by a gain of 6. DCR sensed inductor current is function of the winding temperature. The best approach is to set the maximum current limit based on the expected average maximum temperature of the inductor windings.

$$DCR_{Tmax} = DCR_{25C} \cdot (1 + 0.00393 \, (T_{max} - 25))$$

(eq. 3)

Calculate the current limit voltage:

$$V_{ILIMIT} \cong 6 \cdot \left(I_{MIN\_OCP} \cdot DCR_{Tmax} + \frac{DCR_{Tmax} \cdot V_{out}}{2 \cdot V_{in} \cdot F_{sw}} \cdot \left(\frac{V_{in} - V_{out}}{L} - (N-1) \cdot \frac{V_{out}}{L} \right) \right)$$

(eq. 4)

Solve for the individual resistors:

$$RLIM2 = \frac{V_{ILIMIT} \cdot R_{TOTAL}}{2 \cdot V}$$

(eq. 5)

$$RLIM1 = R_{TOTAL} - RLIM2$$

(eq. 6)

Final Equation for the Current Limit Threshold

$$I_{LIMIT}(T_{inductor}) \cong \frac{\left(\frac{2 \cdot V \cdot RLIM2}{RLIM1 + RLIM2} \right)}{6 \cdot (DCR_{25C} \cdot (1 + 0.00393(T_{Inductor} - 25)))} - \frac{V_{out}}{2 \cdot V_{in} \cdot F_{sw}} \cdot \left(\frac{V_{in} - V_{out}}{L} - (N-1) \cdot \frac{V_{out}}{L} \right)$$

(eq. 7)

The inductors on the demo board have a DCR at 25°C of 0.75 mΩ. Selecting the closest available values of 16.9 kΩ for RLIM1 and 13.7 kΩ for RLIM2 yield a nominal operating frequency of 330 kHz and an approximate current limit of 152 A at 100°C. The total sensed current can be observed as a scaled voltage at the VDRP pin added to a positive, no–load offset of approximately 1.3 V.

Inductor Selection

When using inductor current sensing it is recommended that the inductor does not saturate by more than 10% at maximum load. The inductor also must not go into hard saturation before current limit trips. The demo board includes a four phase output filter using the T50–8 core from Micrometals with 4turns and a DCR target of 0.75 mΩ @ 25°C. Smaller DCR values can be used, however, current sharing accuracy and droop accuracy decrease as DCR decreases. Use the excel spreadsheet for regulation accuracy calculations for a specific value of DCR.

Inductor Current Sense Compensation

The NCP5387 uses the inductor current sensing method. This method uses an RC filter to cancel out the inductance of the inductor and recover the voltage that is the result of the current flowing through the inductor's DCR. This is done by matching the RC time constant of the current sense filter to the L/DCR time constant. The first cut approach is to use a 0.1 μF capacitor for C and then solve for R.

$$Rsense(T) = \frac{L}{0.1 \cdot \mu F \cdot DCR_{25C} \cdot (1 + 0.00393 \cdot (T-25))} \quad \text{(eq. 8)}$$
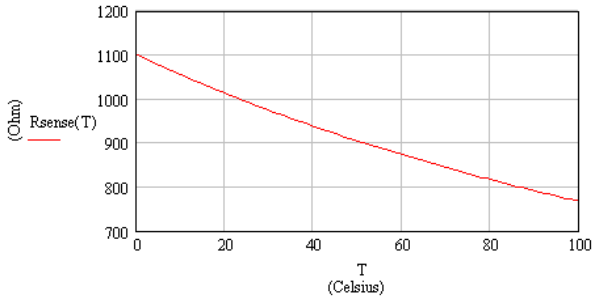
Figure 36.

The demo board inductor measured 350 nH and 0.75 mΩ at room temp. The actual value used for Rsense was 4.42 kΩ which matches the equation for Rsense at approximately 50C. Because the inductor value is a function of load and inductor temperature final selection of R is best done experimentally on the bench by monitoring the Vdroop pin and performing a step load test on the actual solution.

Simple Average PSPICE Model

A simple state average model shown in Figure 37 can be used to determine a stable solution and provide insight into the control system.
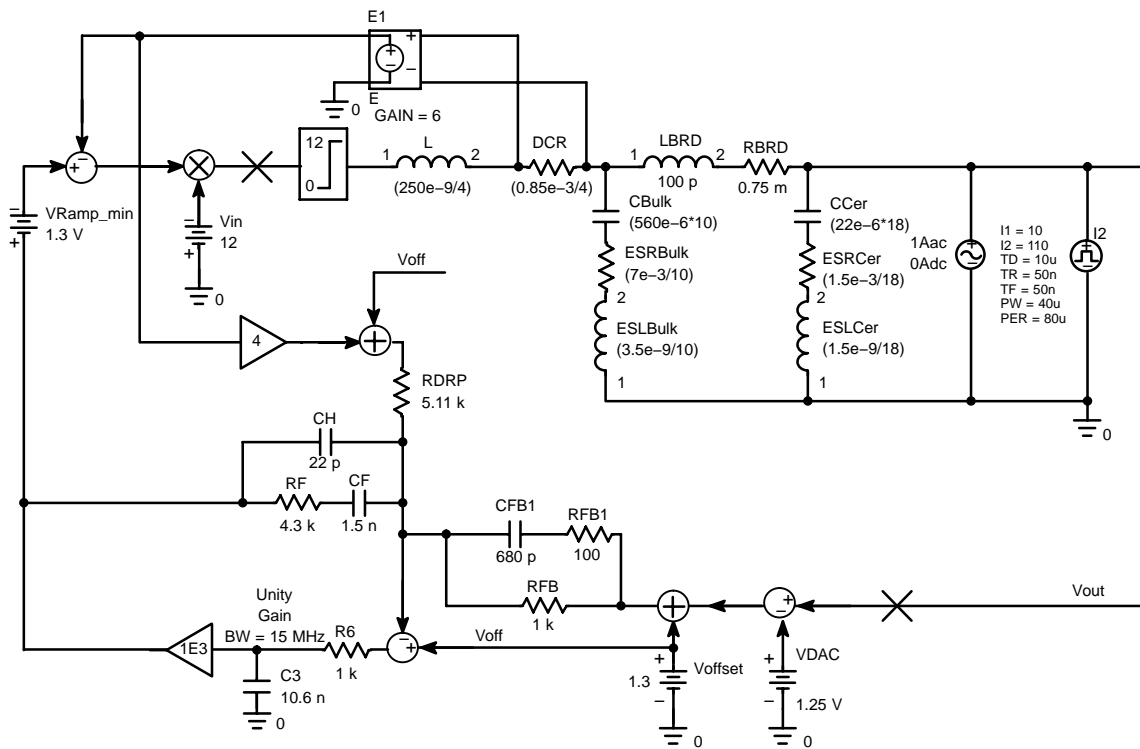
Figure 37.

A complex switching model is available by request which includes a more detailed board parasitic for this demo board.

Compensation and Output Filter Design

The values shown on the demo board are a good place to start for any similar output filter solution. The dynamic performance can then be adjusted by swapping out various individual components.

If the required output filter and switching frequency are significantly different, it's best to use the available PSPICE models to design the compensation and output filter from scratch.

The design target for this demo board was 1.0 mΩ out to 2.0 MHz. The phase switching frequency is currently set to 330 kHz. It can easily be seen that the board impedance of 0.75 mΩ between the load and the bulk capacitance has a large effect on the output filter. In this case the ten 560 μF

bulk capacitors have an ESR of 7.0 mΩ. Thus the bulk ESR plus the board impedance is 0.7 mΩ + 0.75 mΩ or 1.45 mΩ. The actual output filter impedance does not drop to 1.0 mΩ until the ceramic breaks in at over 375 kHz. The controller must provide some loop gain slightly less than one out to a frequency in excess 300 kHz. At frequencies below where the bulk capacitance ESR breaks with the bulk capacitance, the DC–DC converter must have sufficiently high gain to control the output impedance completely. Standard Type−3 compensation works well with the NCP5387. RFB1 should be kept above 50 Ω to ensure compensator stability.

The goal is to compensate the system such that the resulting gain generates constant output impedance from DC up to the frequency where the ceramic takes over holding the impedance below 1.0 mΩ. See the example of the locations of the poles and zeros that were set to optimize the model above.
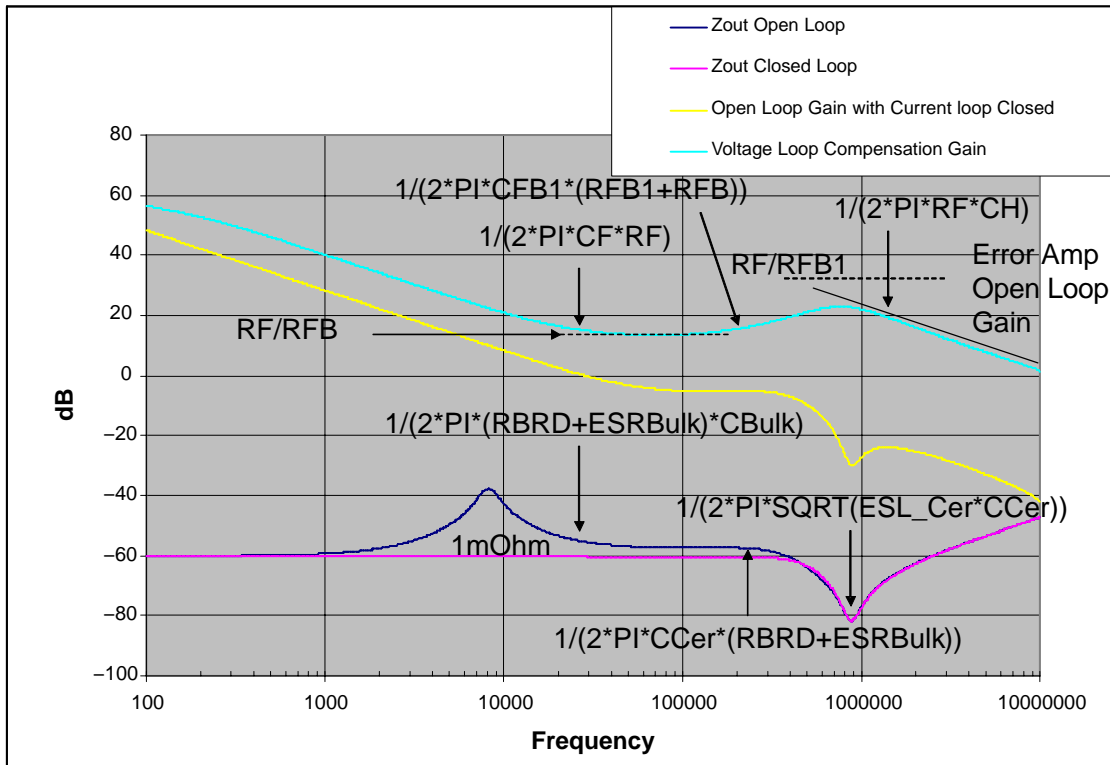
Figure 38.

By matching the following equations a good set of starting compensation values can be found for a typical mixed bulk and ceramic capacitor type output filter.

$$\frac{1}{2\pi \cdot CF \cdot RF} = \frac{1}{2\pi \cdot (RBRD + ESRBulk) \cdot CBulk}$$

$$\frac{1}{2\pi \cdot CFBI \cdot (RFBI + RFB)} = \frac{1}{2\pi \cdot CCer * (RBRD + ESRBulk)}$$

(eq. 9)

RFB should be set to provide optimal thermal compensation in conjunction with thermistor RT2, RISO1 and RISO2. With RFB set to 1.0 kΩ, RFB1 is usually set to 100 Ω for maximum phase boost, and the value of RF is typically set to 4.0 kΩ.

Droop Injection and Thermal Compensation

The VDRP signal is generated by summing the sensed output currents for each phase and applying a gain of approximately six. VDRP is externally summed into the feedback network by the resistor RDRP. This introduces an

$$DCR(T) = DCR_{25C} \cdot (1 + 0.00393(T-25))$$ (eq. 11)

The system can be thermally compensated to cancel this effect to a great degree by adding an NTC (negative temperature coefficient resistor) in parallel with RFB to reduce the droop gain as the temperature increases. The NTC device is nonlinear. Putting a resistor in series with the

offset which is proportional to the output current thereby forcing a controlled, resistive output impedance.

RRDP determines the target output impedance by the basic equation:

$$\frac{Vout}{Iout} = Zout = \frac{RFB \cdot DCR \cdot 6}{RDRP}$$

$$RDRP = \frac{RFB \cdot DCR \cdot 6}{Zout}$$ (eq. 10)

The value of the inductor's DCR varies with temperature according to the following equation 11:

NTC helps make the device appear more linear with temperature. The series resistor is split and inserted on both sides of the NTC to reduce noise injection into the feedback loop. The recommended total value for RISO1 plus RISO2 is approximately 1.0 kΩ.

The output impedance varies with inductor temperature by the equation:

$$\vdash Zout(T) = \frac{RFB \cdot DCR_{25C} \cdot (1 + 0.00393(T-25)) \cdot 6}{Rdroop}$$ (eq. 12)

By including the NTC RT2 and the series isolation resistors the new equation becomes:

$$Zout(T) = \frac{\frac{RFB \cdot (RISO1 + RT2(T) + RISO2)}{RFB + RISO1 + RT2(T) + RISO2} \cdot DCR_{25C} \cdot (1 + 0.00393(T-25)) \cdot 6}{Rdroop}$$ (eq. 13)

The typical equation of a NTC is based on a curve fit equation 14.

$$RT2(T) = RT2_{25C} \cdot e^{\beta\left[\left(\frac{1}{273 + T}\right) - \left(\frac{1}{298}\right)\right]}$$ (eq. 14)

The demo board is populated with a 10 kΩ NTC with a Beta of 4300. Figure 39 shows the uncompensated and compensated output impedance versus temperature.
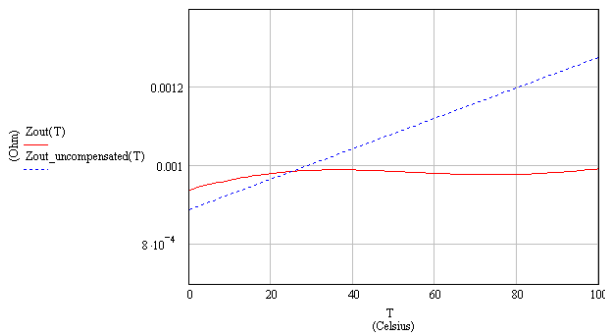
Figure 39. Uncompensated and Compensated Output Impedance vs. Temperature

ON Semiconductor provides an excel spreadsheet to help with the selection of the NTC. The actual selection of the NTC will be effected by the location of the output inductor with respect to the NTC and airflow, and should be verified with an actual system thermal solution.

VRHOT and VRFAN

The NCP5387 provides two threshold sensitive comparators for thermal monitoring. The circuit consists of two comparators that compare the voltage on the NTC pin to an internal resistor divider connected to VREF. By powering the external temperature sense divider with VREF the tolerance of the VREF voltage is canceled out. The data sheet specifications for the thresholds are shown as ratios with respect to VREF.

The following equations can be used to find the temperature trip points.

$$RT1(T) = RT1_{25C} \cdot e^{\beta\left[\left(\frac{1}{273 + T}\right) - \left(\frac{1}{298}\right)\right]}$$ (eq. 15)

$$Ratio_{NTC}(T) : \frac{RNTC2 + RT1(T)}{RNTC1 + RNTC2 + RT1(T)}$$ (eq. 16)

The demo board contains a 68 K NTC for RT1 with a Beta of 4750. RNTC1 is populated with 15 kΩ and RNTC2 is populated with a zero ohm resistor. Figure 40 is a plot of equation 16. The horizontal, trip threshold voltages intersect the Ratio_{NTC} curve at the respective activation and deactivation temperature.
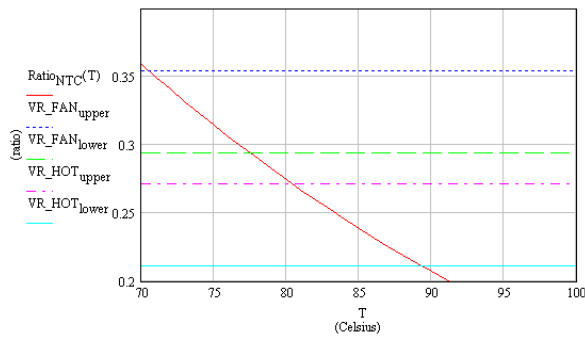
Figure 40.

OVP

The overvoltage protection threshold is not adjustable. OVP protection is enabled as soon as soft−start begins and is disabled when the part is disabled. When OVP is tripped, the controller commands all four gate drivers to enable their low side MOSFETs, and VR_RDY transitions low. In order to recover from an OVP condition, V_{CC} must fall below the UVLO threshold. See the state diagram for further details. The OVP circuit monitors the output of DIFFOUT. If the DIFFOUT signal reaches 180 mV above the nominal 1.3 V offset the OVP will trip. The DIFFOUT signal is the difference between the output voltage and the DAC voltage (minus 19 mV if in VR10 or VR11 modes) plus the 1.3 V internal offset. This results in the OVP tracking the DAC voltage even during a dynamic change in the VID setting during operation.

Gate Driver and MOSFET Selection

ON Semiconductor provides the NCP3418B as a companion gate driver IC. The NCP3418B driver is optimized to work with a range of MOSFETs commonly used in CPU applications. The NCP3418B provides special functionality and is required for the high performance dynamic VID operation of the part. Contact your local ON Semiconductor applications engineer for MOSFET recommendations.

Board Stack−Up

The demo board follows the recommended Intel Stack−up and copper thickness as shown.
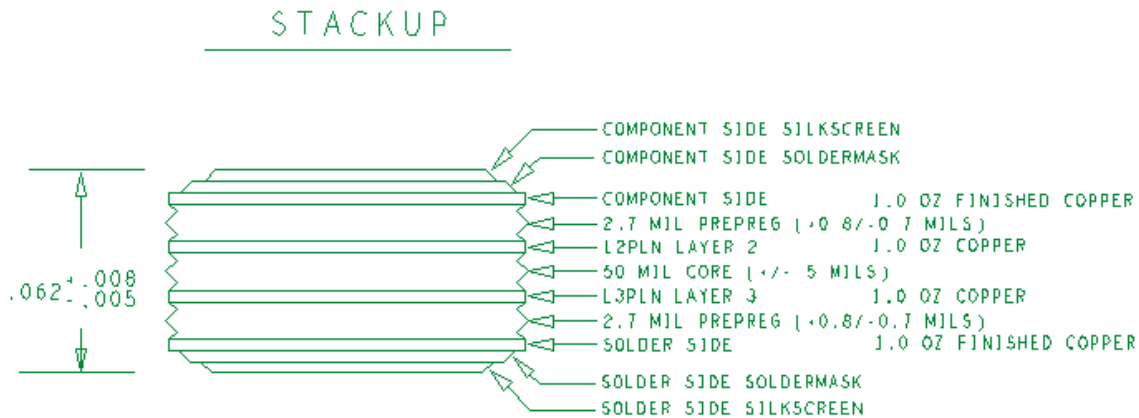
Figure 41.

Board Layout

A complete Allegro ATX and BTX demo board layout file and schematics are available by request at www.onsemi.com and can be viewed using the Allegro Free Physical Viewer 15.x from the Cadence website http://www.cadence.com/.

Close attention should be paid to the routing of the sense traces and control lines that propagate away from the controller IC. Routing should follow the demo board example. For further information or layout review contact ON Semiconductor.

NCP5387

PACKAGE DIMENSIONS

QFN40, 6x6, 0.5P
CASE 488AR–01
ISSUE A

PIN ONE LOCATION

2X | △ | 0.15 | C

2X | △ | 0.15 | C

TOP VIEW

// | 0.10 | C

(A3)

A

40X | △ | 0.08 | C

SIDE VIEW A1

⊿ | 0.10 | C

SEATING PLANE
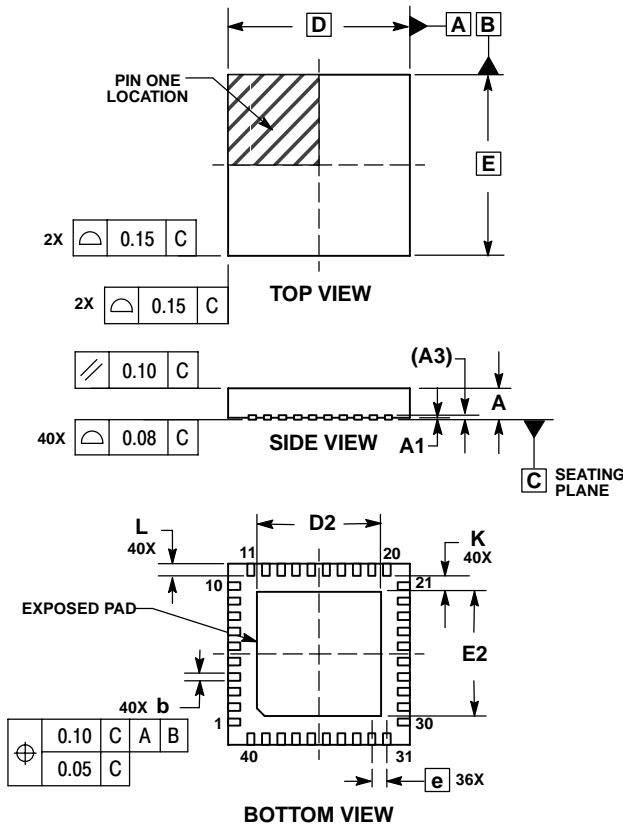
NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSIONS: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30mm FROM TERMINAL
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

DIM	MILLIMETERS	
---	MIN	MAX
A	0.80	1.00
A1	0.00	0.05
A3	0.20 REF	
b	0.18	0.30
D	6.00 BSC	
D2	4.00	4.20
E	6.00 BSC	
E2	4.00	4.20
e	0.50 BSC	
L	0.30	0.50
K	0.20	–––

L
40X

EXPOSED PAD

D2

K
40X

E2

40X b

⊕ | 0.10 | C | A | B
| 0.05 | C |

e 36X

BOTTOM VIEW

SOLDERING FOOTPRINT*

6.30

4.20

40X 0.65

1

4.20 6.30

40X 0.30

36X 0.50 PITCH
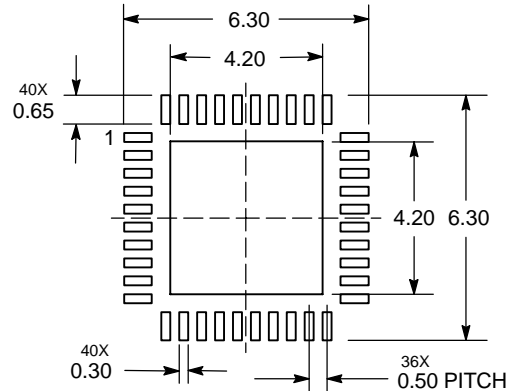
DIMENSIONS: MILLIMETERS

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

The product described herein (NCP5387), may be covered by one or more of the following U.S. patents: 7,057,381. There may be other patents pending.